

[54] MODULAR JACK PATCH BLOCK

[75] Inventor: Brian E. Reed, New Hartford, Conn.

[73] Assignee: The Siemon Company, Watertown, Conn.

[**] Term: 14 Years

[21] Appl. No.: 291,432

[22] Filed: Dec. 28, 1988

[52] U.S. Cl. D13/147

[58] Field of Search D13/133, 134, 135, 136, D13/140-147, 152, 154; 439/716, 718, 628, 626, 668, 571, 554, 344, 418, 391

[56] References Cited

U.S. PATENT DOCUMENTS

D. 276,426	11/1984	DeLuca et al.	D14/256
D. 297,232	8/1988	Gazzo	D14/256
4,669,799	6/1987	Vachhani et al.	439/719 X

OTHER PUBLICATIONS

Burnoy Electronic Products Catalog, p. 43, Modular Adapter.

Primary Examiner—Susan J. Lucas

Attorney, Agent, or Firm—Fishman, Dionne & Cantor

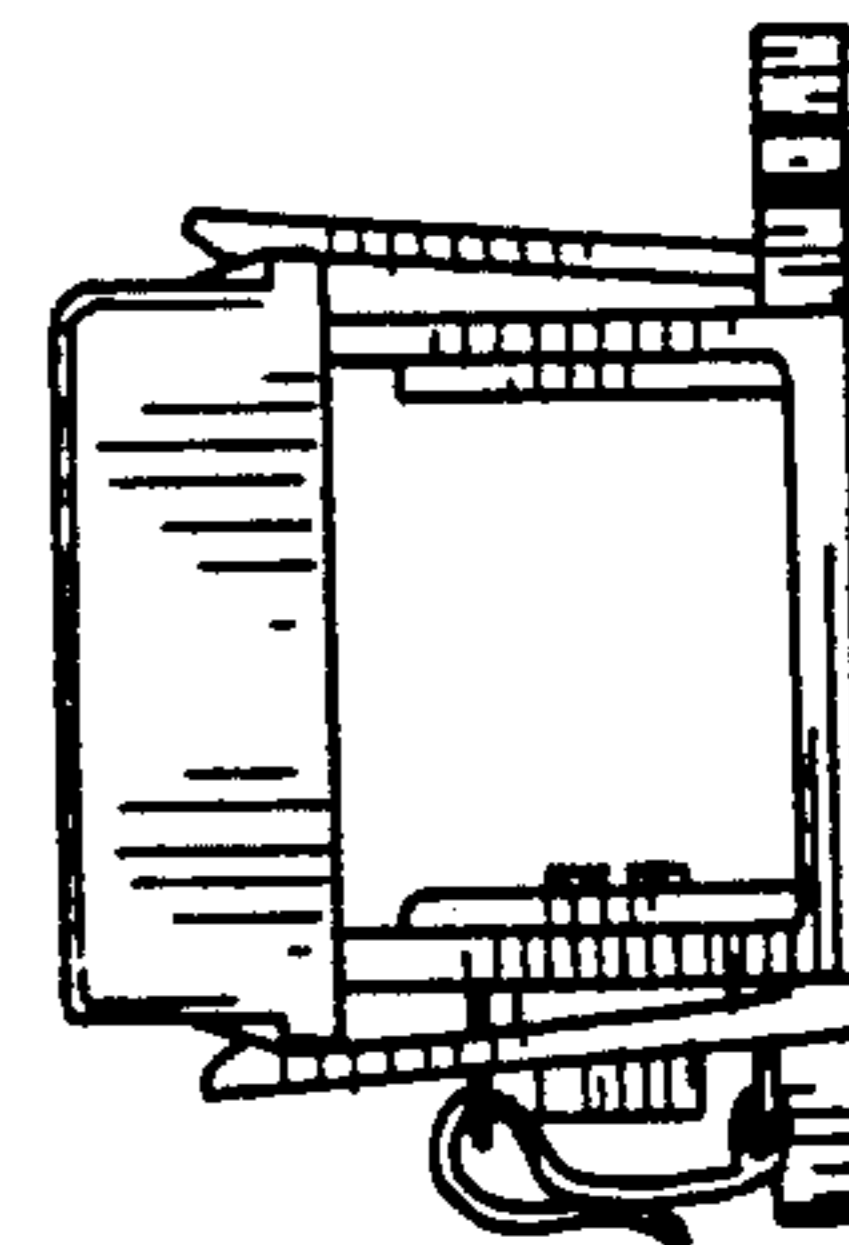
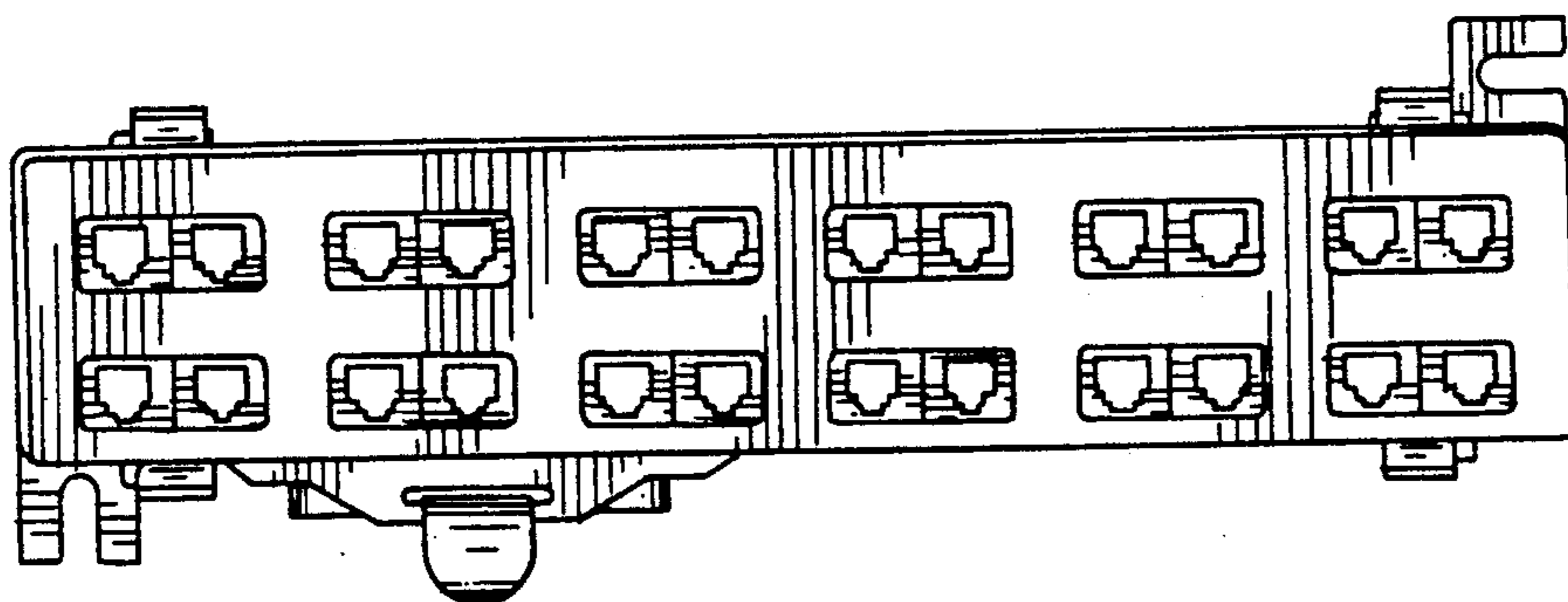
[57] CLAIM

The ornamental design for a modular jack patch block, as shown and described.

DESCRIPTION

FIG. 1 is a bottom plan view of a modular jack patch block showing a first embodiment of my new design;
 FIG. 2 is a top plan view thereof;
 FIG. 3 is a right side elevation view thereof;
 FIG. 4 is a left side elevation view thereof;
 FIG. 5 is a front end elevation view thereof;
 FIG. 6 is a rear end elevation view thereof;
 FIG. 7 is a bottom plan view of a modular jack patch block showing a second embodiment of my new design;
 FIG. 8 is a top plan view thereof;
 FIG. 9 is a right side elevation view thereof;
 FIG. 10 is a left side elevation view thereof;
 FIG. 11 is a front end elevation view thereof;
 FIG. 12 is a rear end elevation view thereof;

FIG. 13 is a bottom plan view of a modular jack patch block showing a third embodiment of my new design;
 FIG. 14 is a top plan view thereof;
 FIG. 15 is a right side elevation view thereof;
 FIG. 16 is a left side elevation view thereof;
 FIG. 17 is a front end elevation view thereof;
 FIG. 18 is a rear end elevation view thereof;
 FIG. 19 is a bottom plan view of a modular jack patch block showing a fourth embodiment of my new design;
 FIG. 20 is a top plan view thereof;
 FIG. 21 is a right elevation view thereof;
 FIG. 22 is a left side elevation view thereof;
 FIG. 23 is a front end elevation view thereof;
 FIG. 24 is a rear end elevation view thereof;
 FIG. 25 is a bottom plan view of a modular jack patch block showing a fifth embodiment of my new design;
 FIG. 26 is a top plan view thereof;
 FIG. 27 is a right side elevation view thereof;
 FIG. 28 is a left side elevation view thereof;
 FIG. 29 is a front end elevation view thereof;
 FIG. 30 is a rear end elevation view thereof;
 FIG. 31 is a bottom plan view of a modular jack patch block showing a sixth embodiment of my new design;
 FIG. 32 is a top plan view thereof;
 FIG. 33 is a right side elevation view thereof;
 FIG. 34 is a left side elevation view thereof;
 FIG. 35 is a front end elevation view thereof;
 FIG. 36 is a rear end elevation view thereof;
 FIG. 37 is a bottom plan view of a modular jack patch block showing a seventh embodiment of my new design;
 FIG. 38 is a top plan view thereof;
 FIG. 39 is a right side elevation view thereof;
 FIG. 40 is a left side elevation view thereof;
 FIG. 41 is a front end elevation view thereof;
 FIG. 42 is a rear end elevation view thereof;
 FIG. 43 is a bottom plan view of a modular jack patch block showing an eighth embodiment of my new design;
 FIG. 44 is a top plan view thereof;
 FIG. 45 is a right elevation view thereof;
 FIG. 46 is a left elevation view thereof;
 FIG. 47 is a front end elevation view thereof;
 FIG. 48 is a rear end elevation view thereof;
 The rear surface of the top panel which would normally be seen through the apertures in the bottom surface is omitted from FIGS. 1, 7, 13, 19, 25, 31, 37 and 43 for clarity of disclosure.



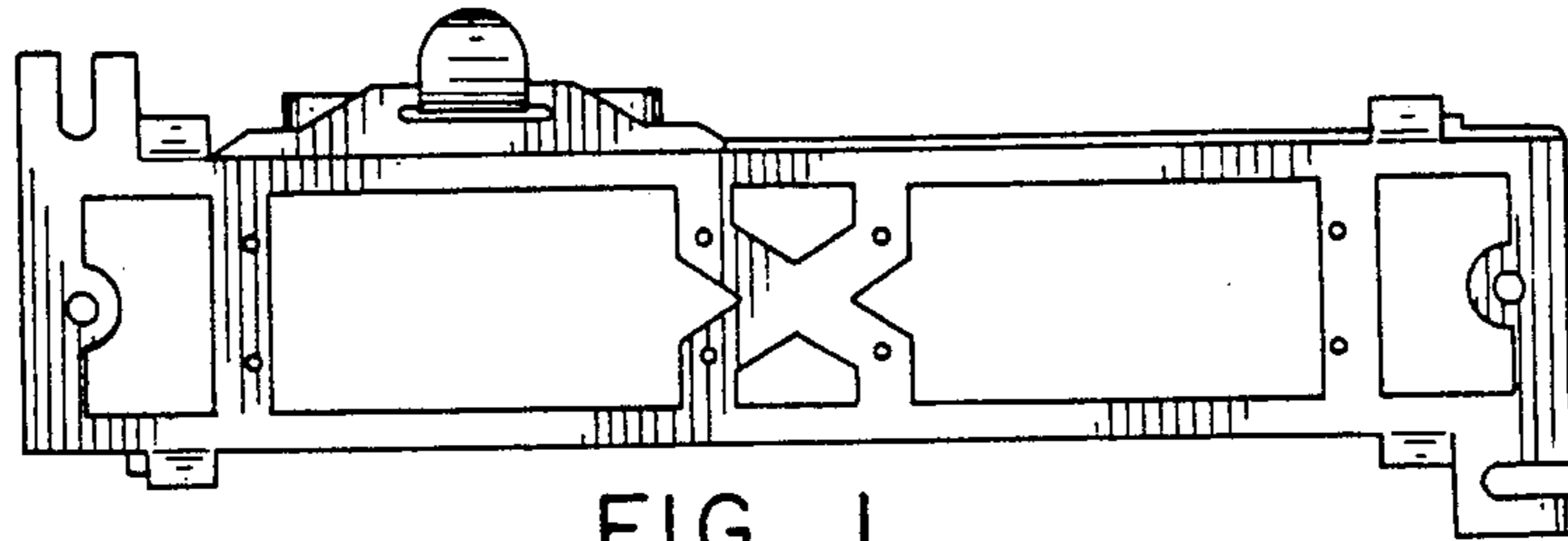


FIG. 1

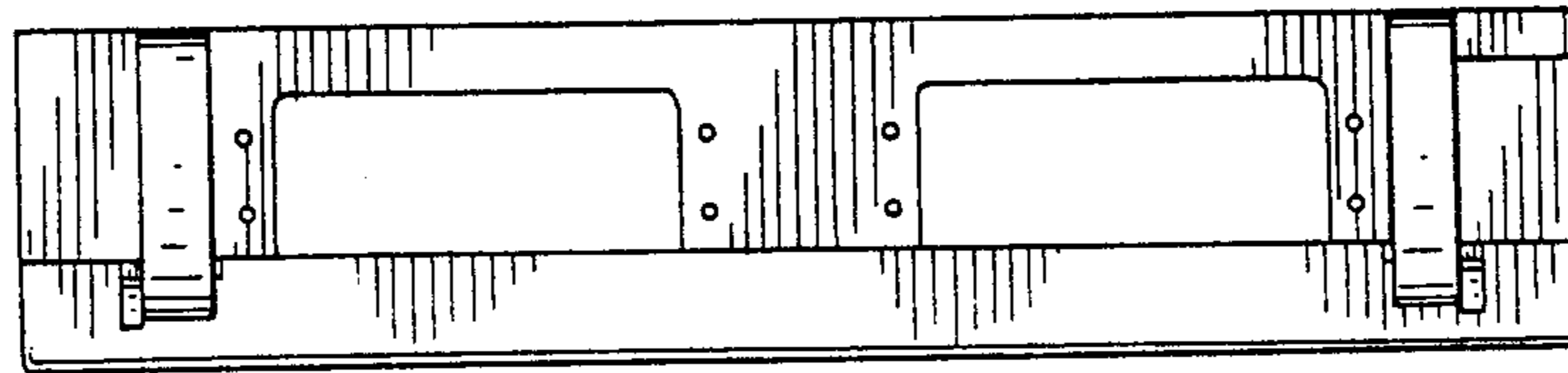


FIG. 3

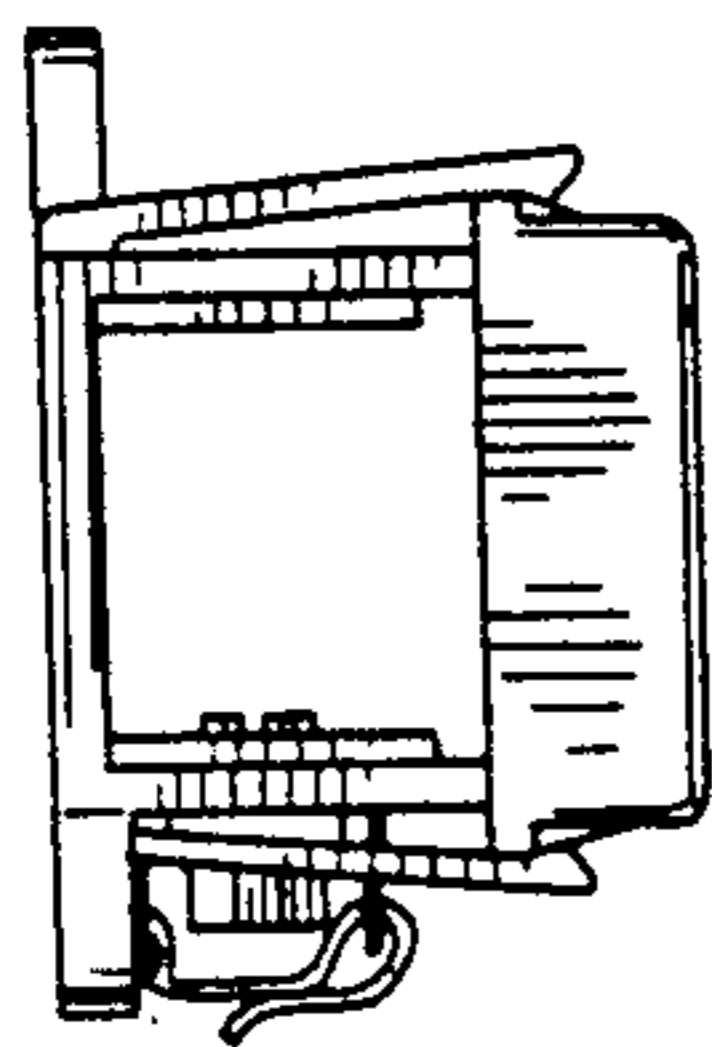


FIG. 6

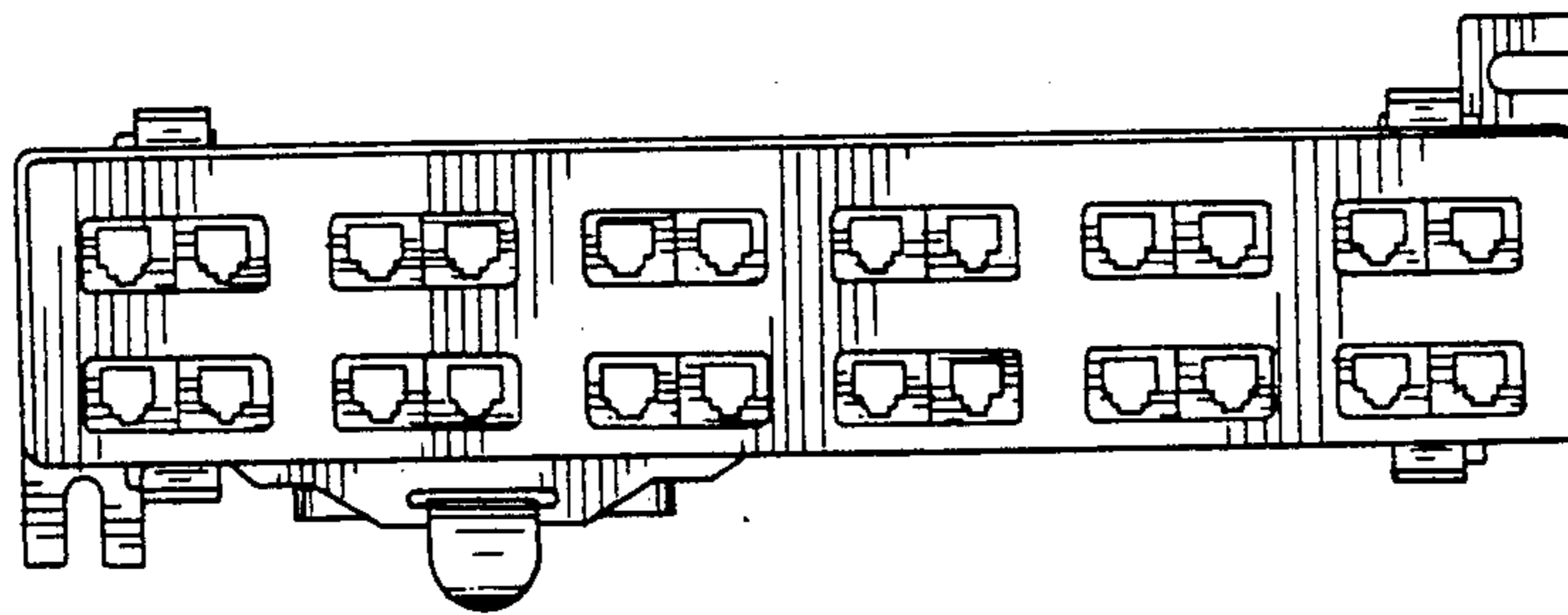


FIG. 2

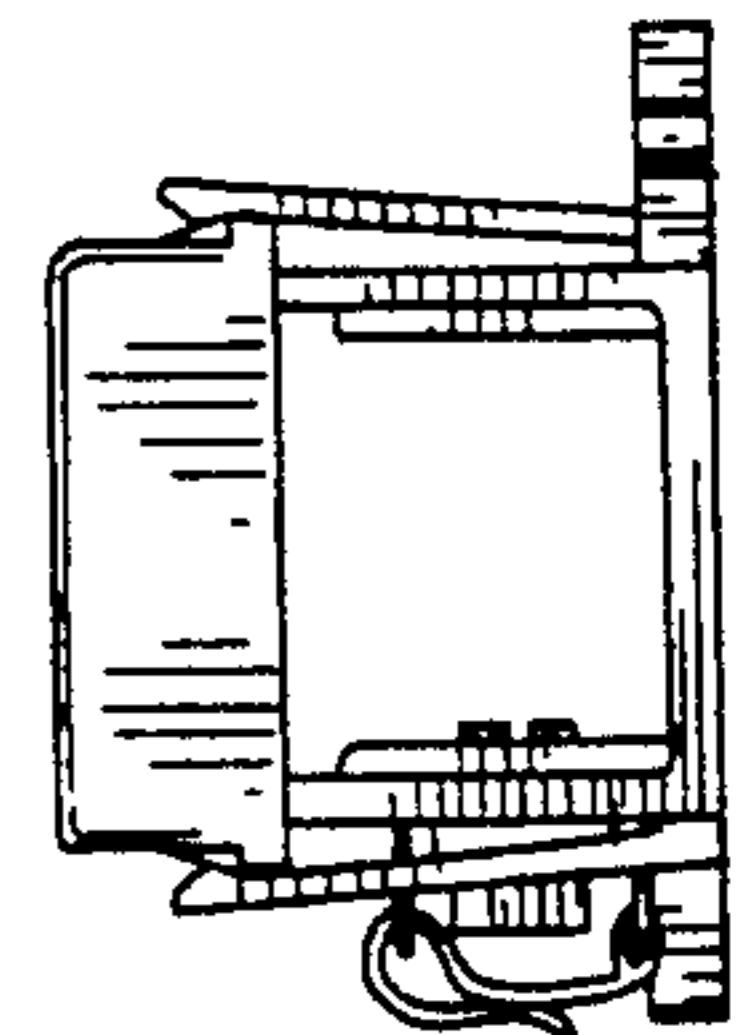


FIG. 5

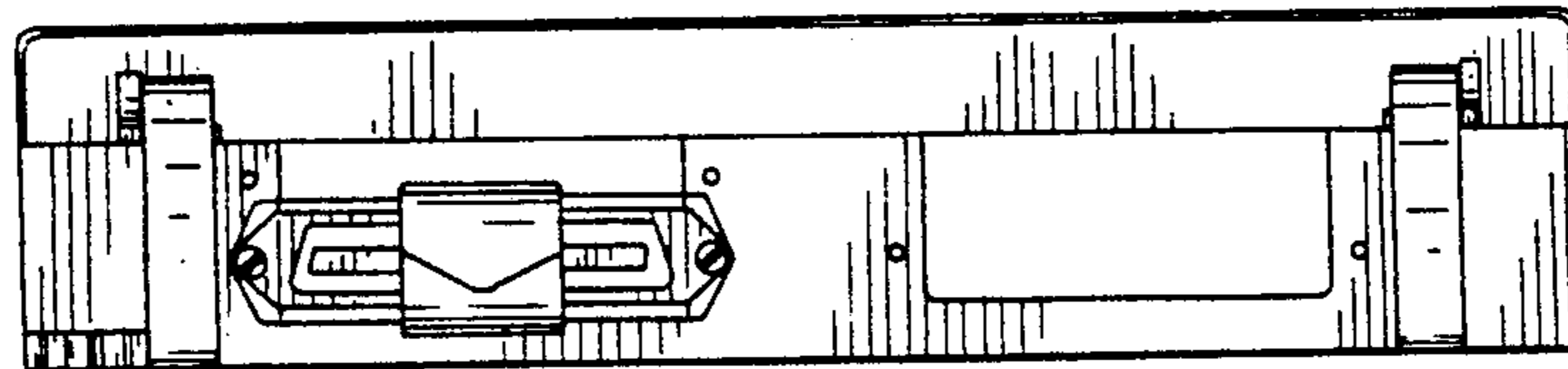


FIG. 4

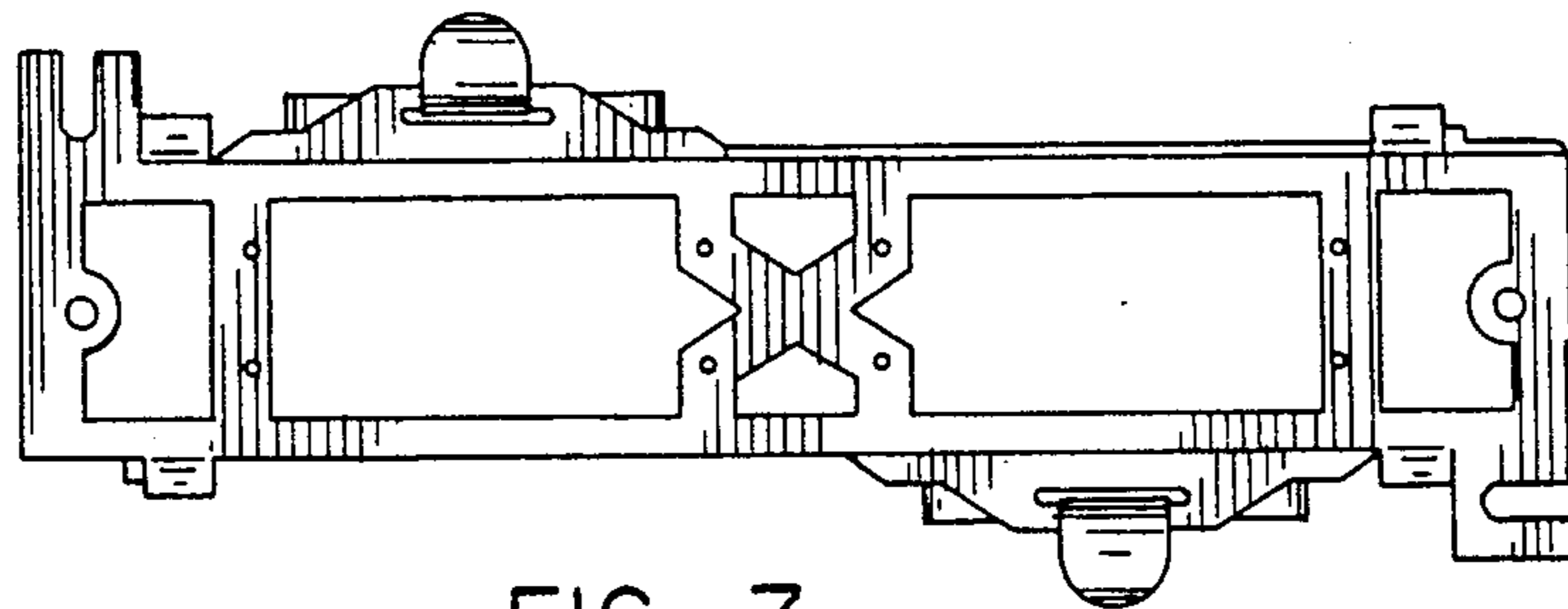


FIG. 7

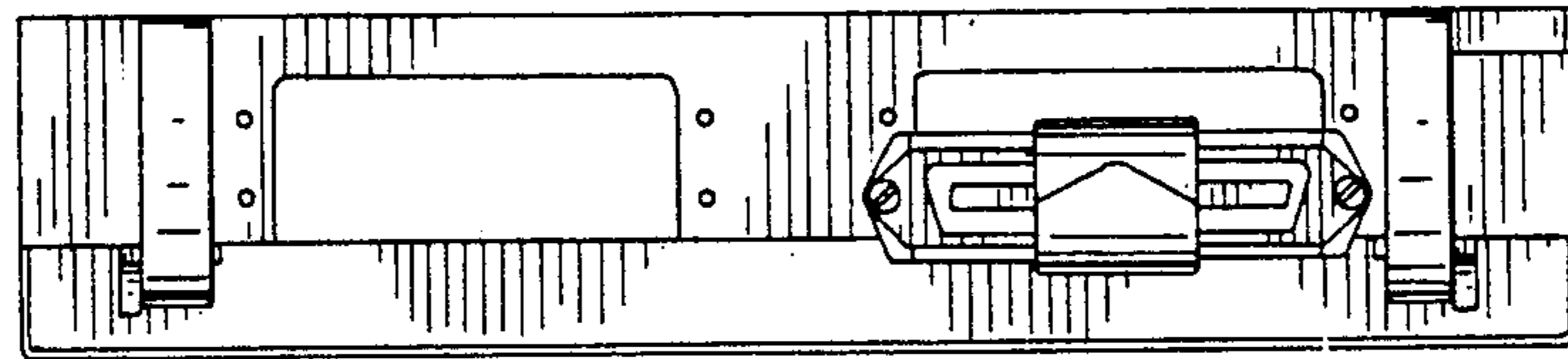


FIG. 9

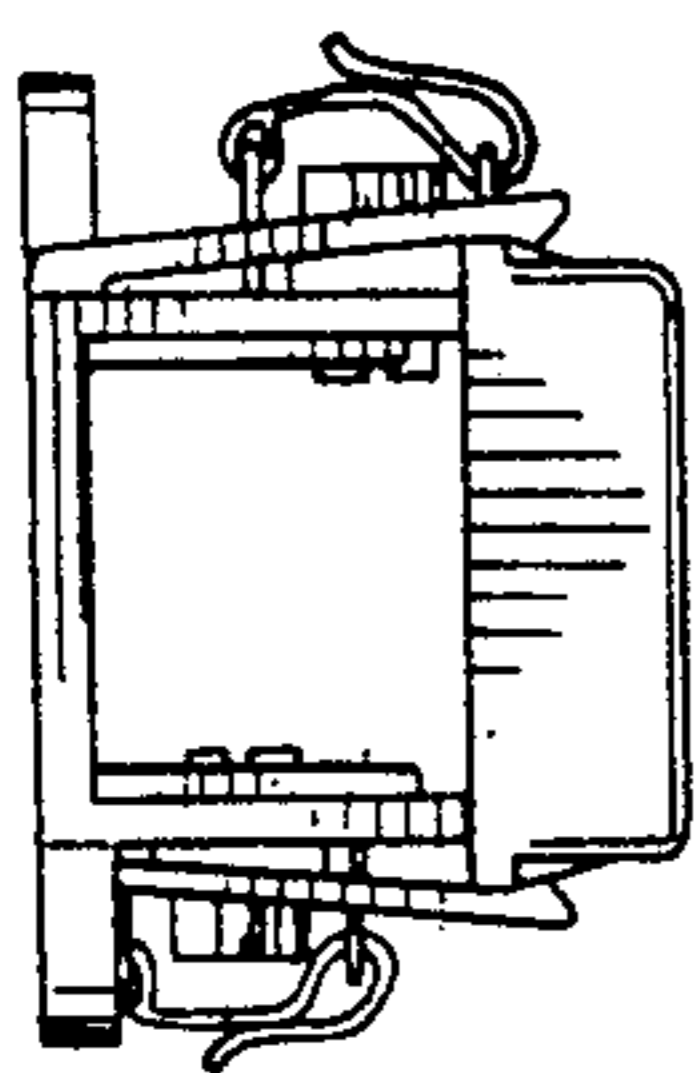


FIG. 12

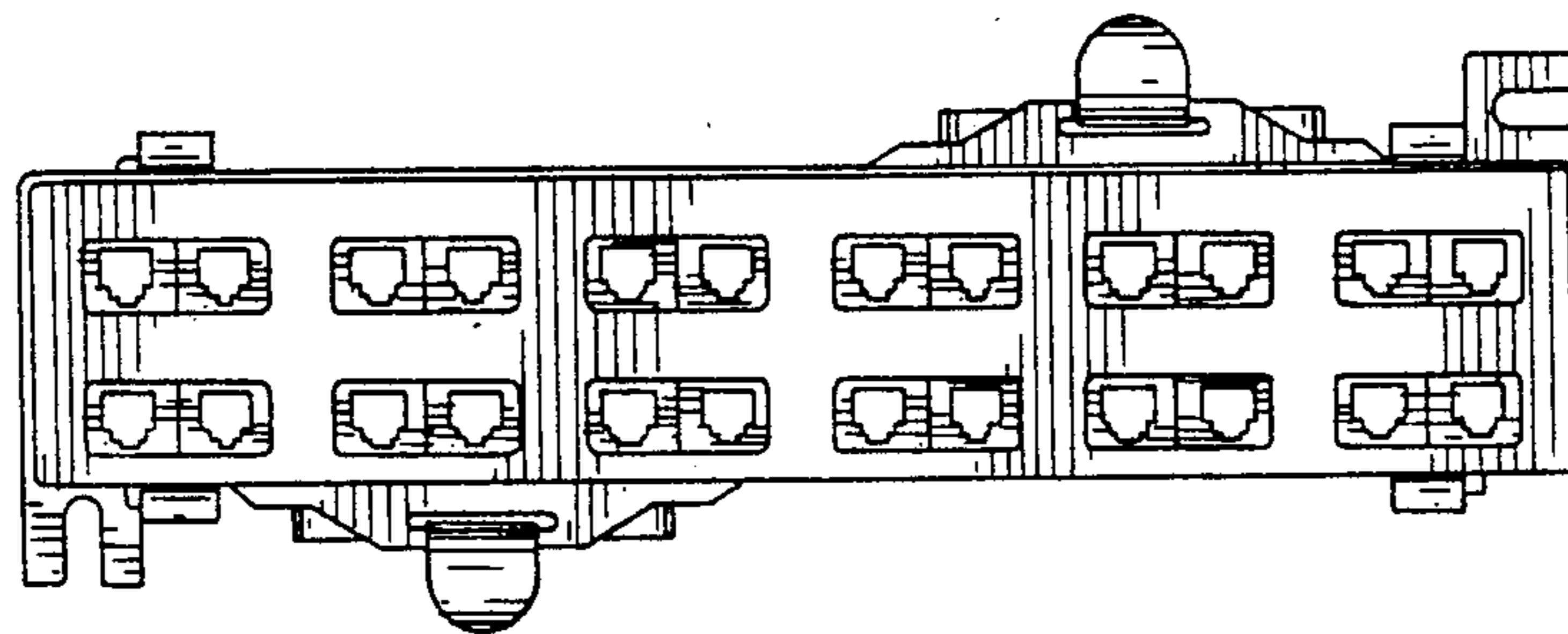


FIG. 8

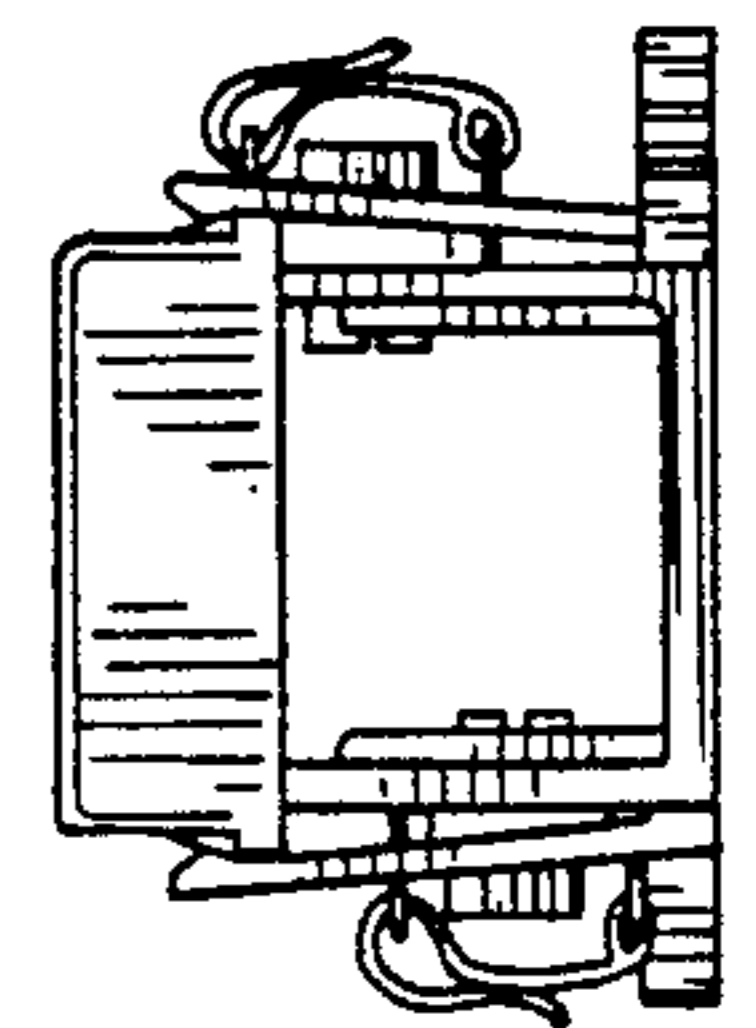


FIG. 11

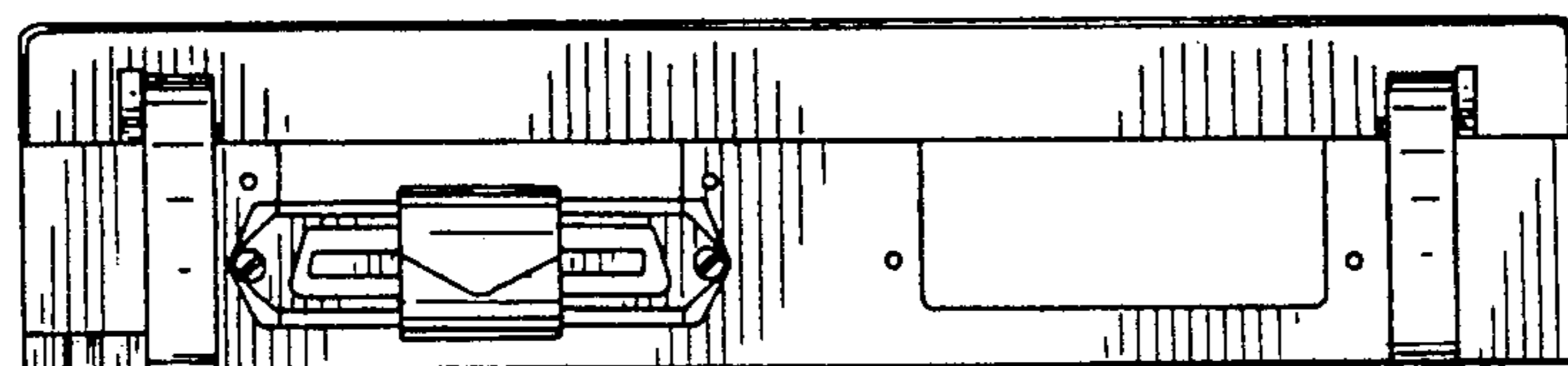


FIG. 10

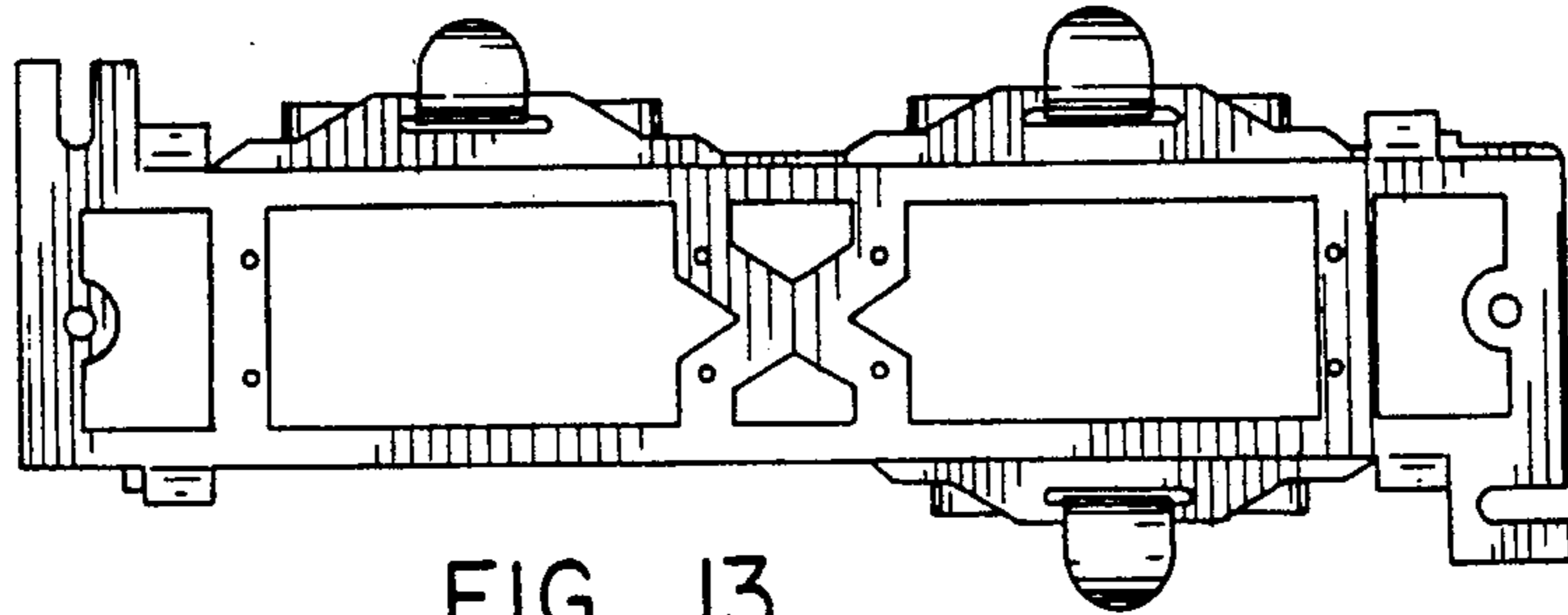


FIG. 13

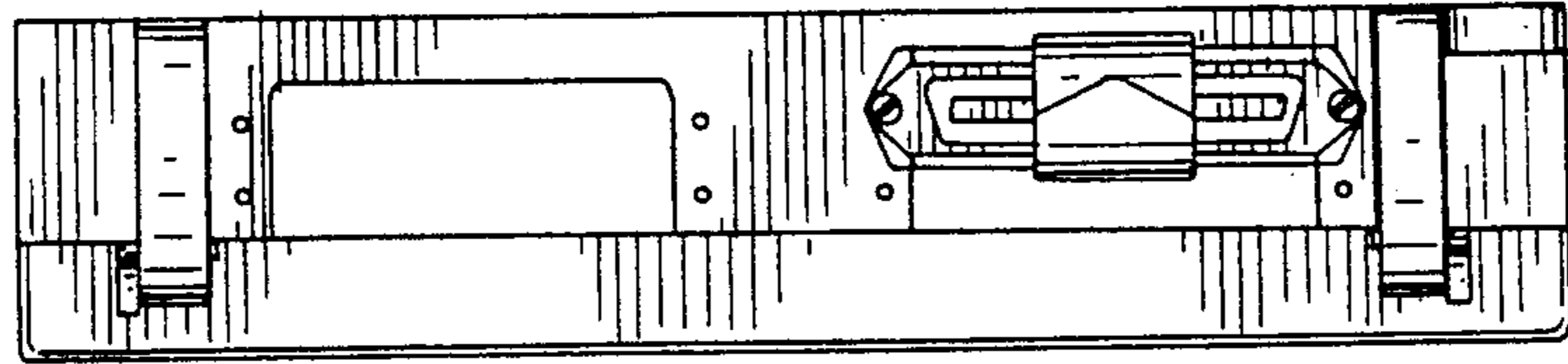


FIG. 15

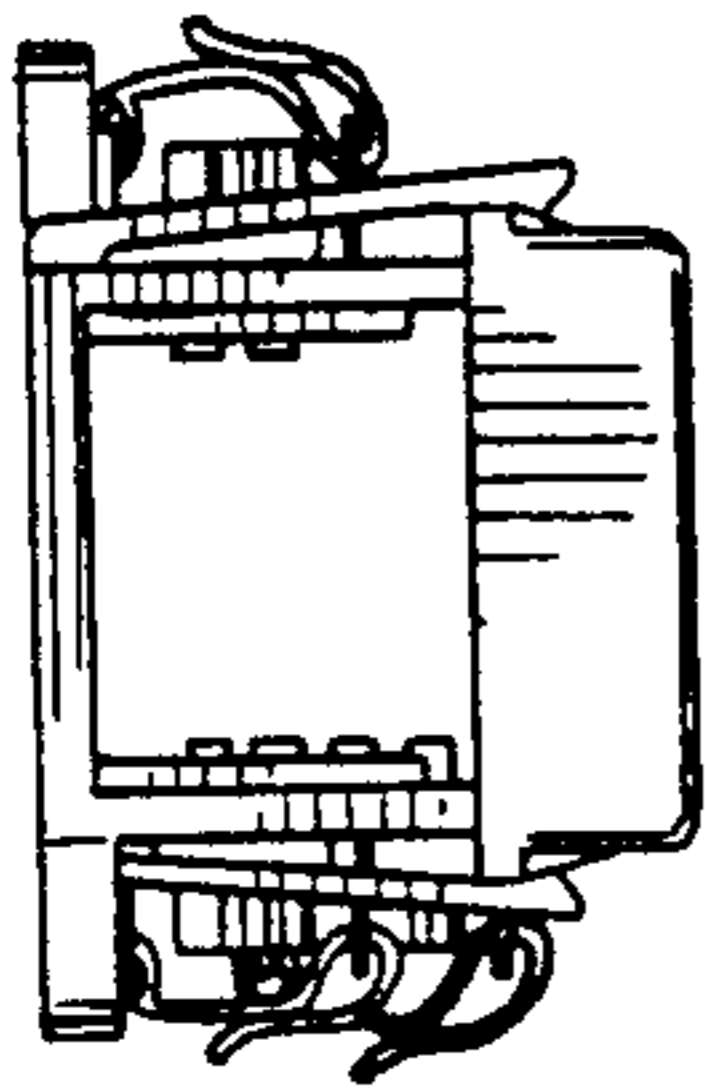


FIG. 18

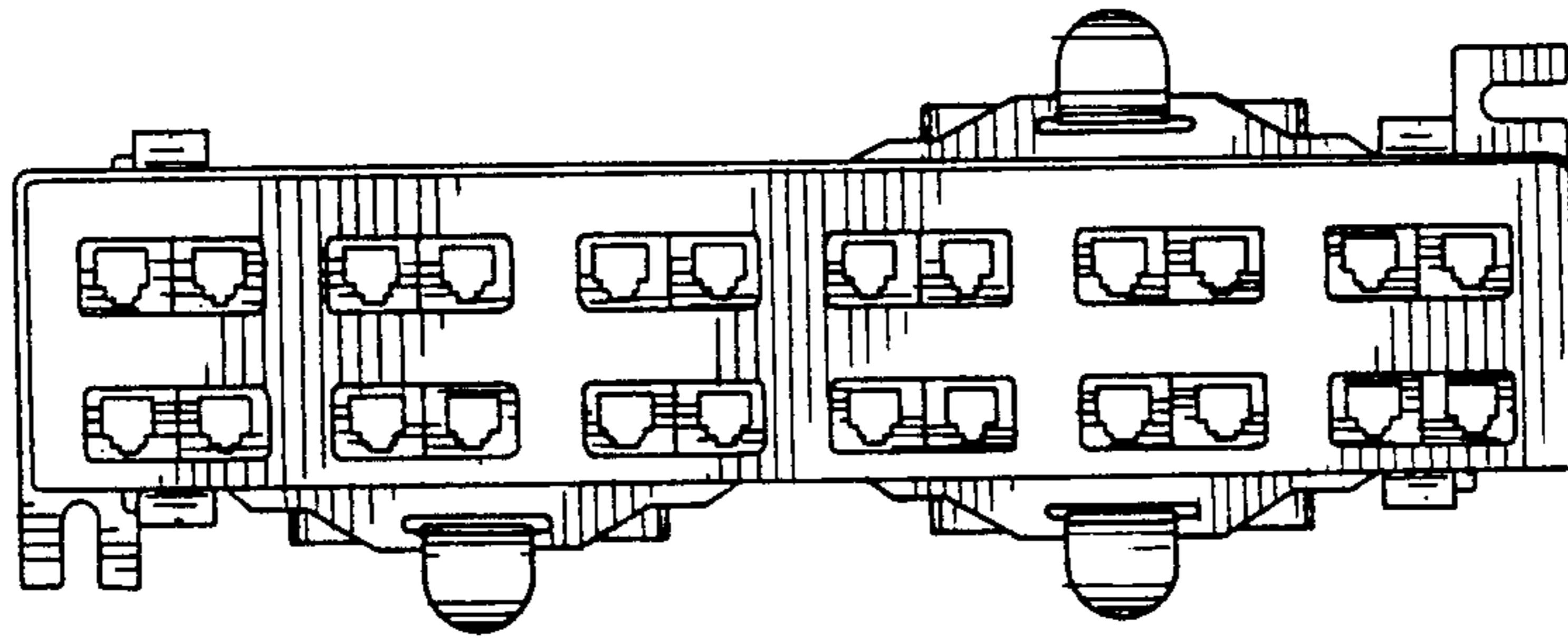


FIG. 14

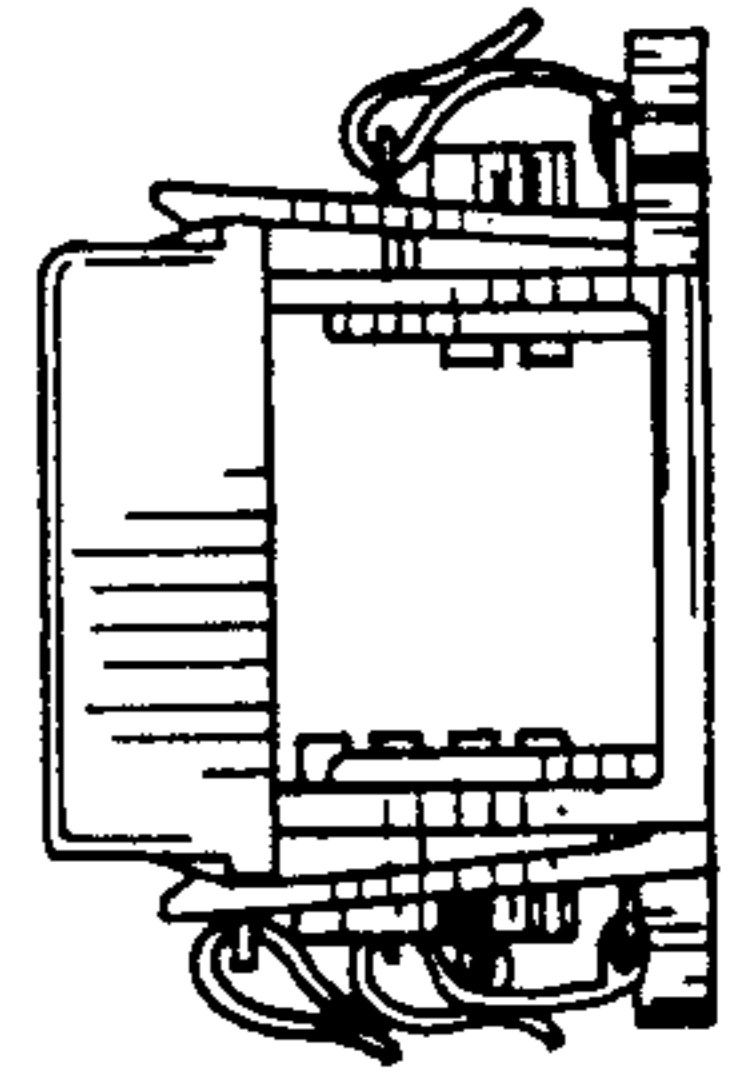


FIG. 17

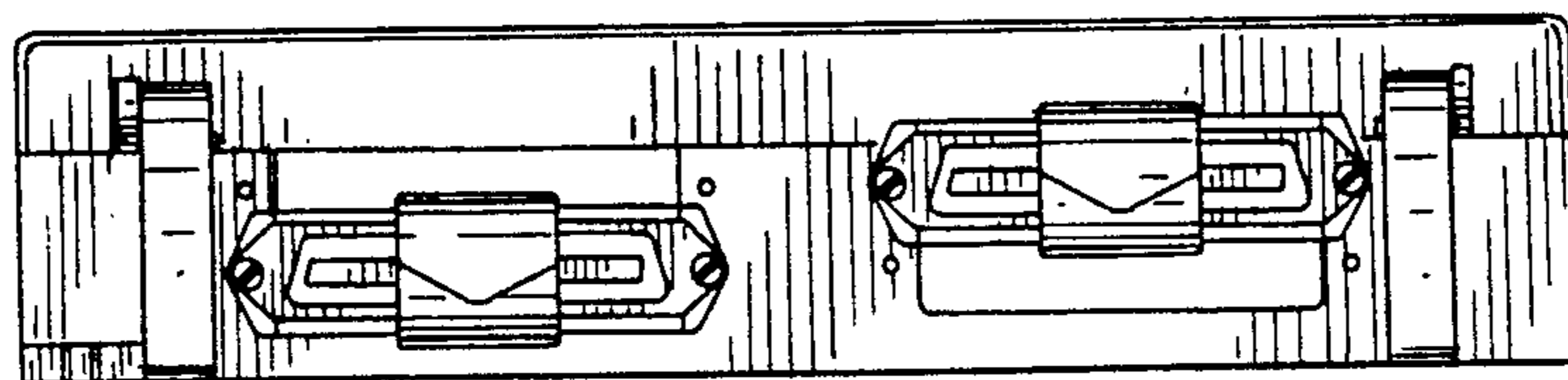


FIG. 16

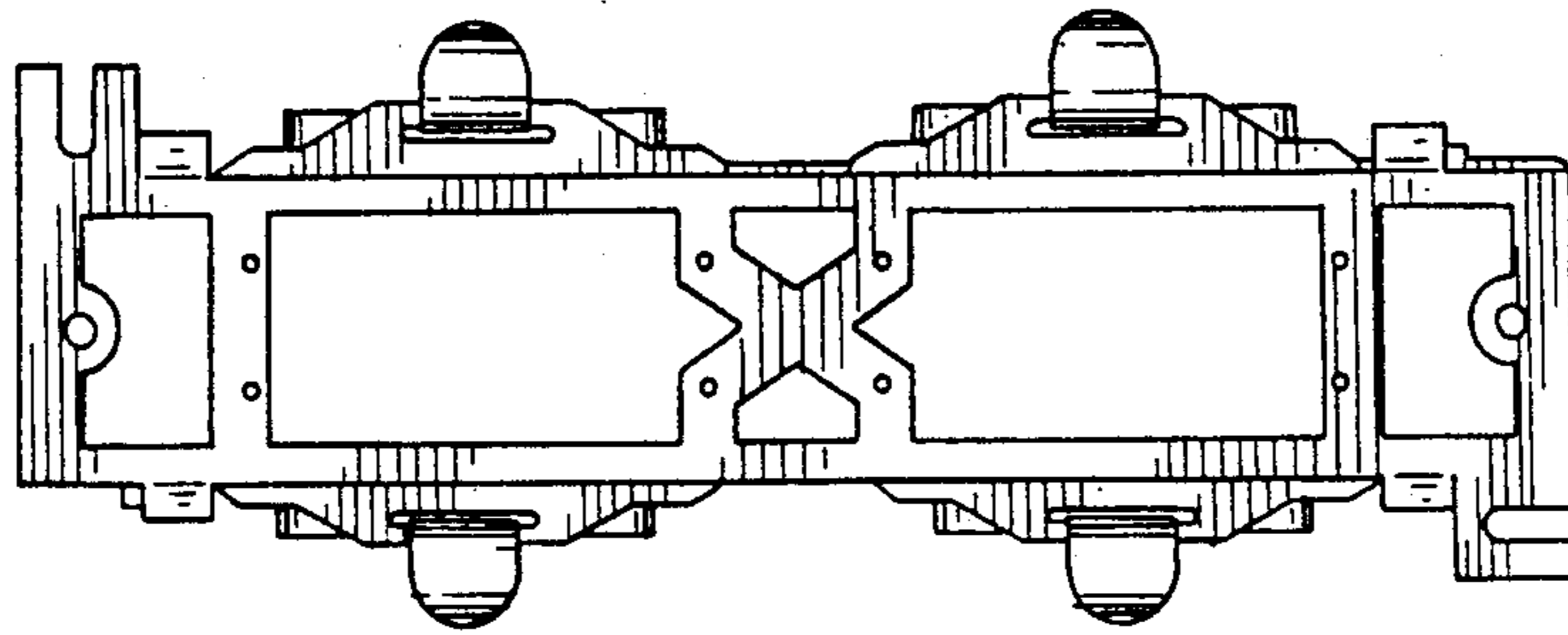


FIG. 19

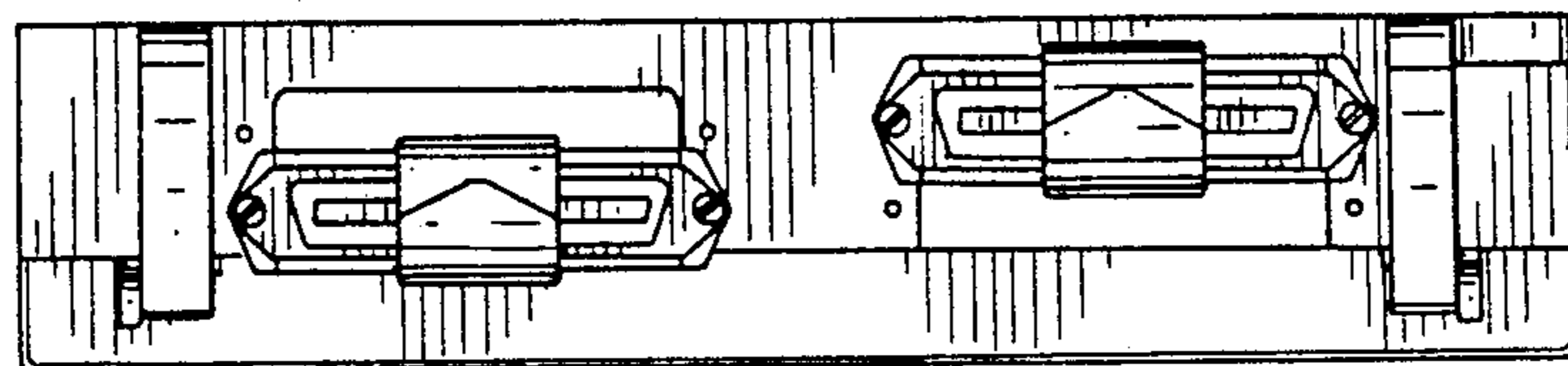


FIG. 21

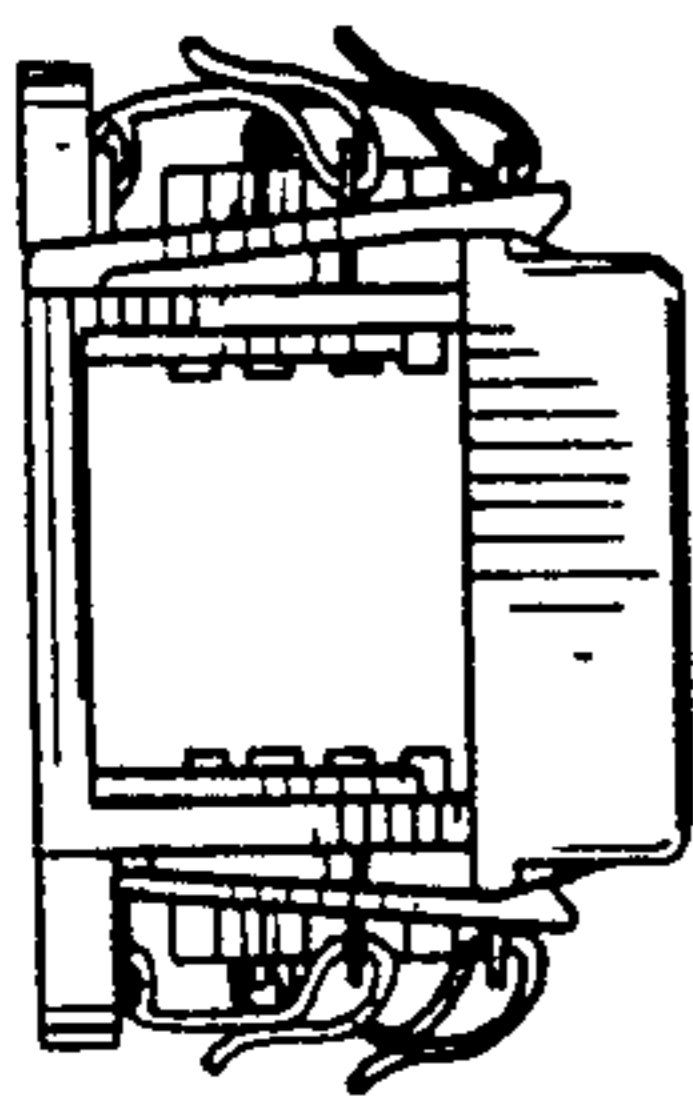


FIG. 24

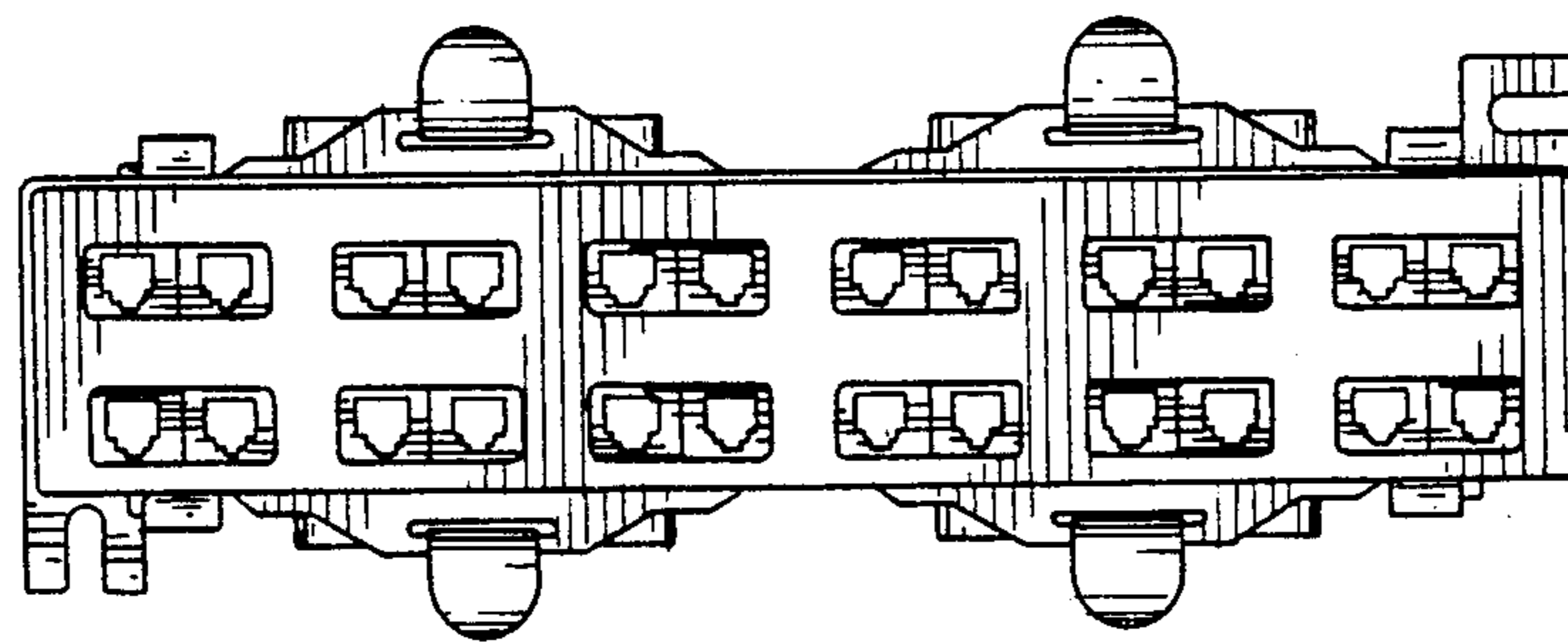


FIG. 20

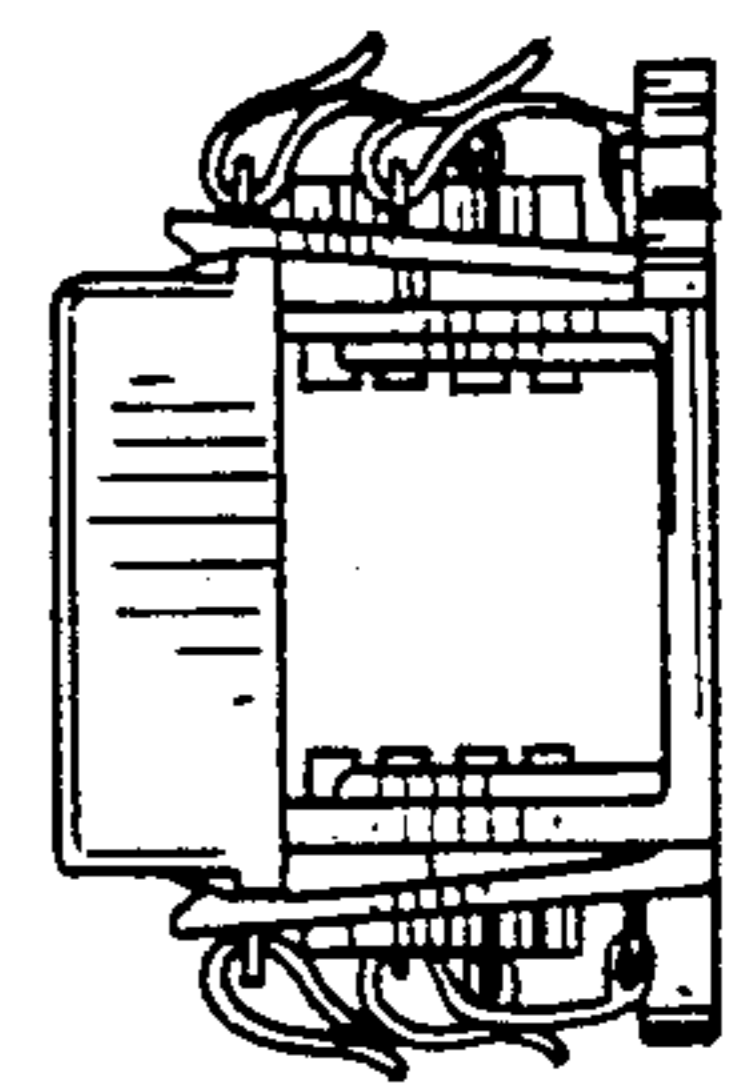


FIG. 23

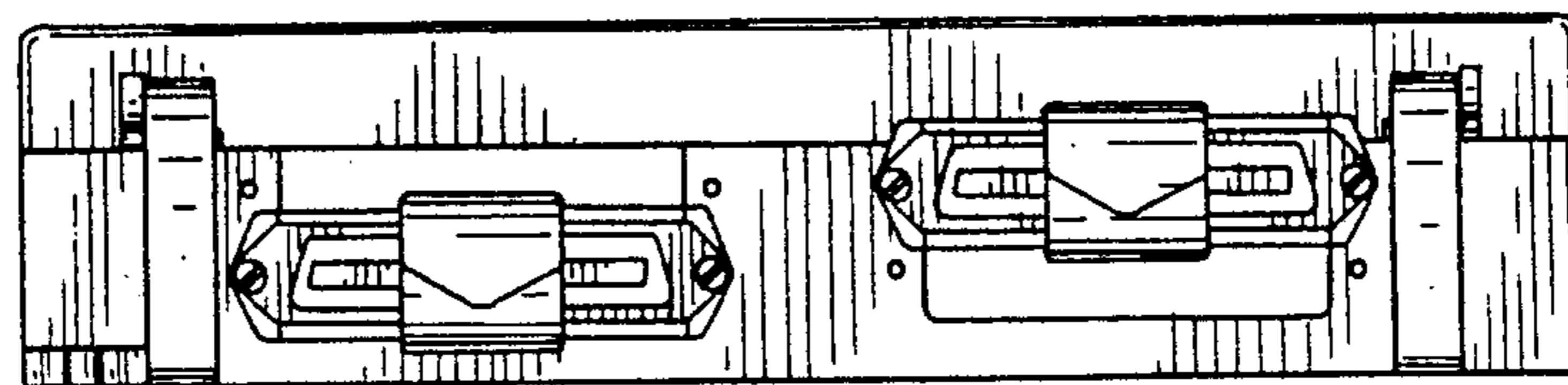


FIG. 22

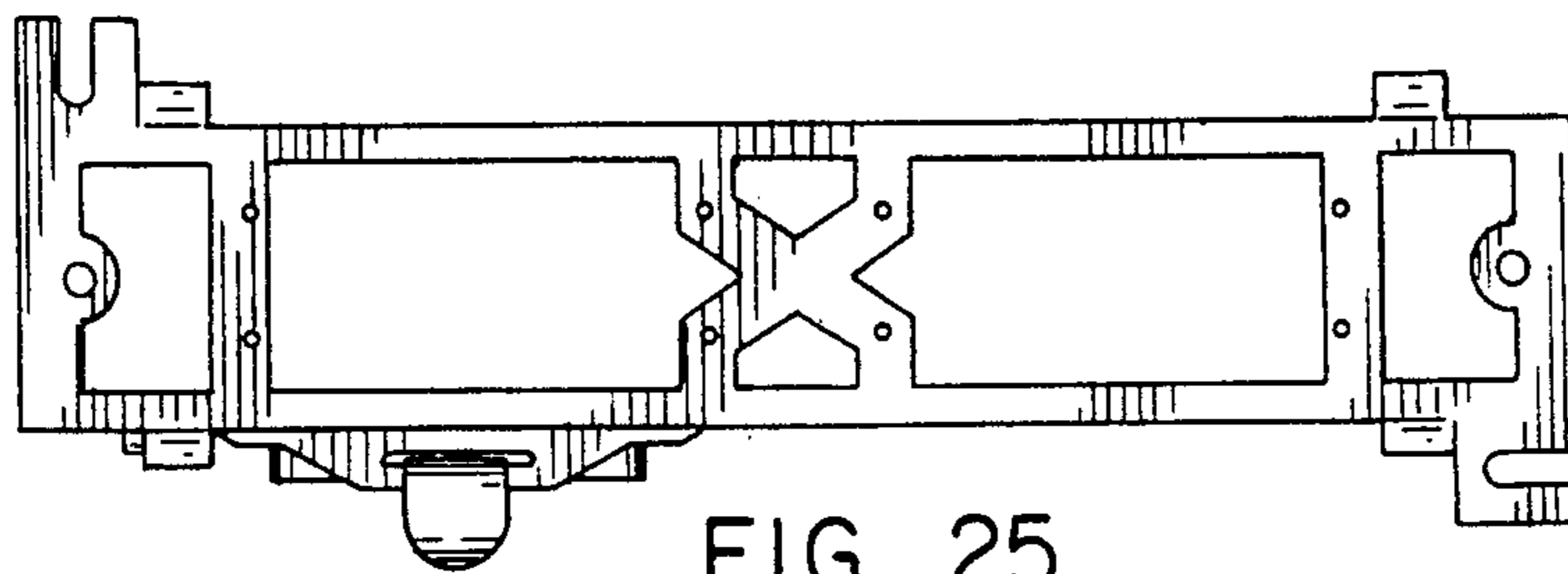


FIG. 25

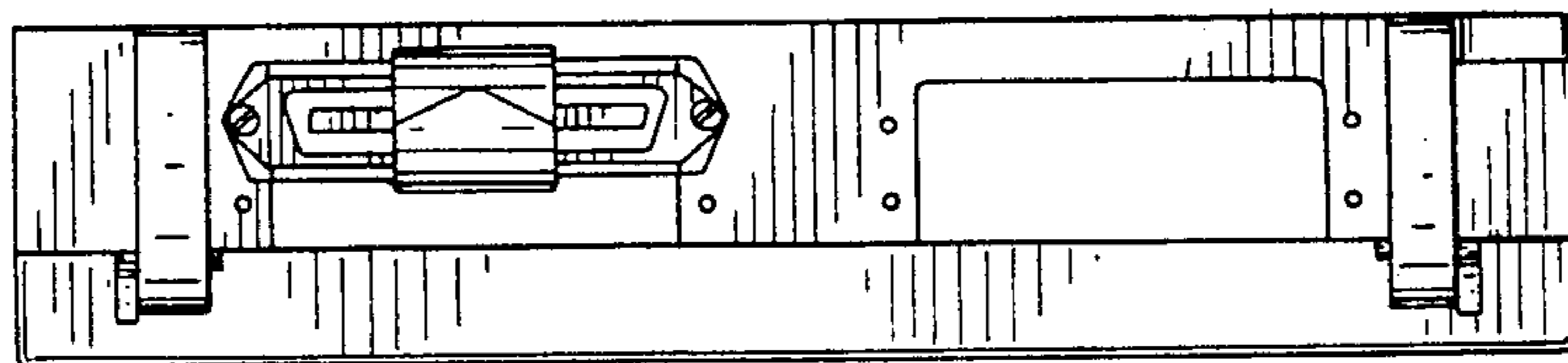


FIG. 27

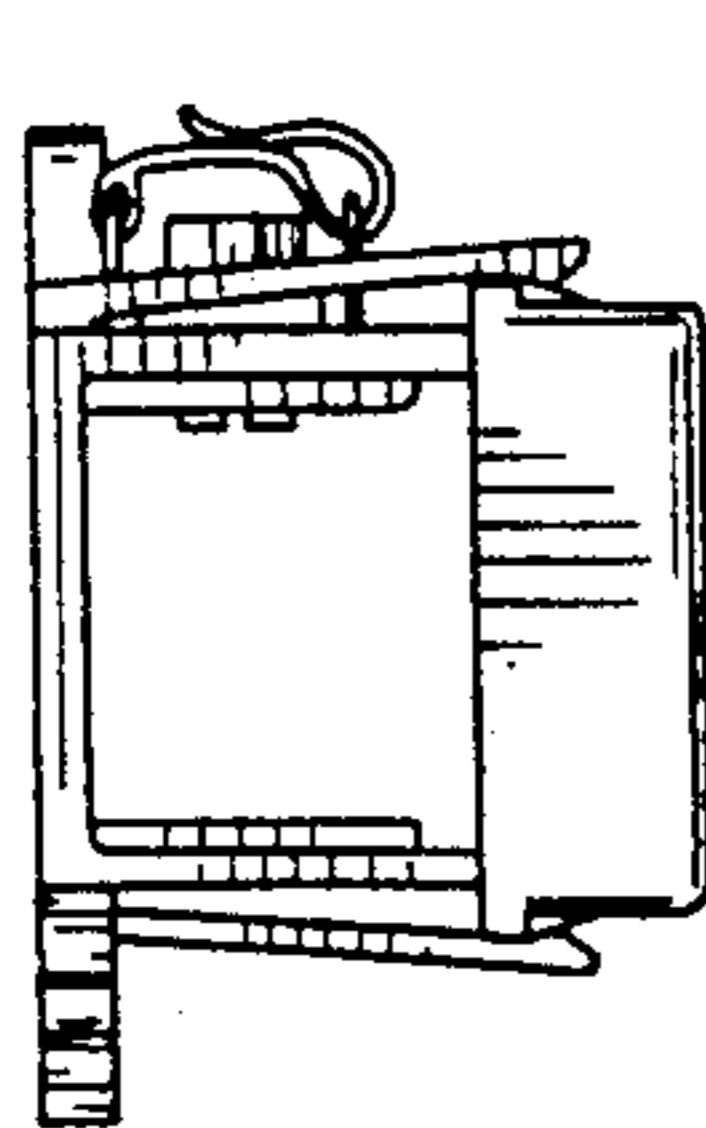


FIG. 30

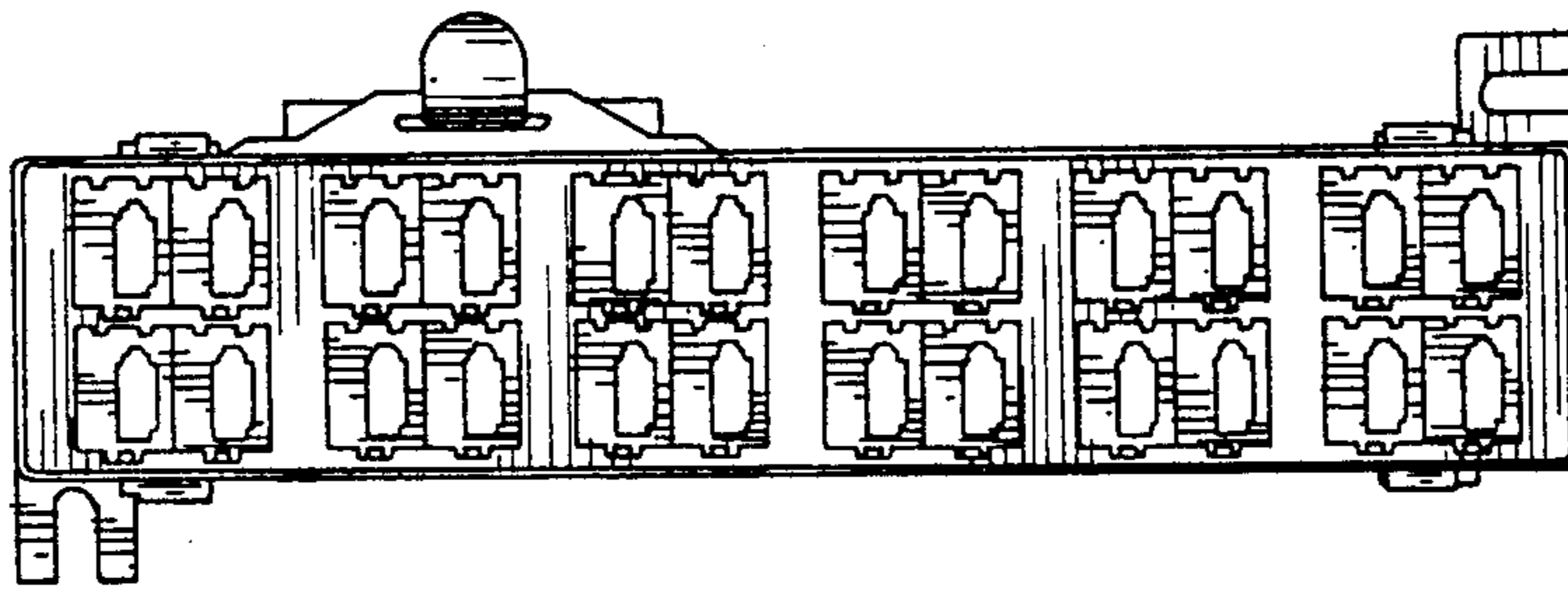


FIG. 26

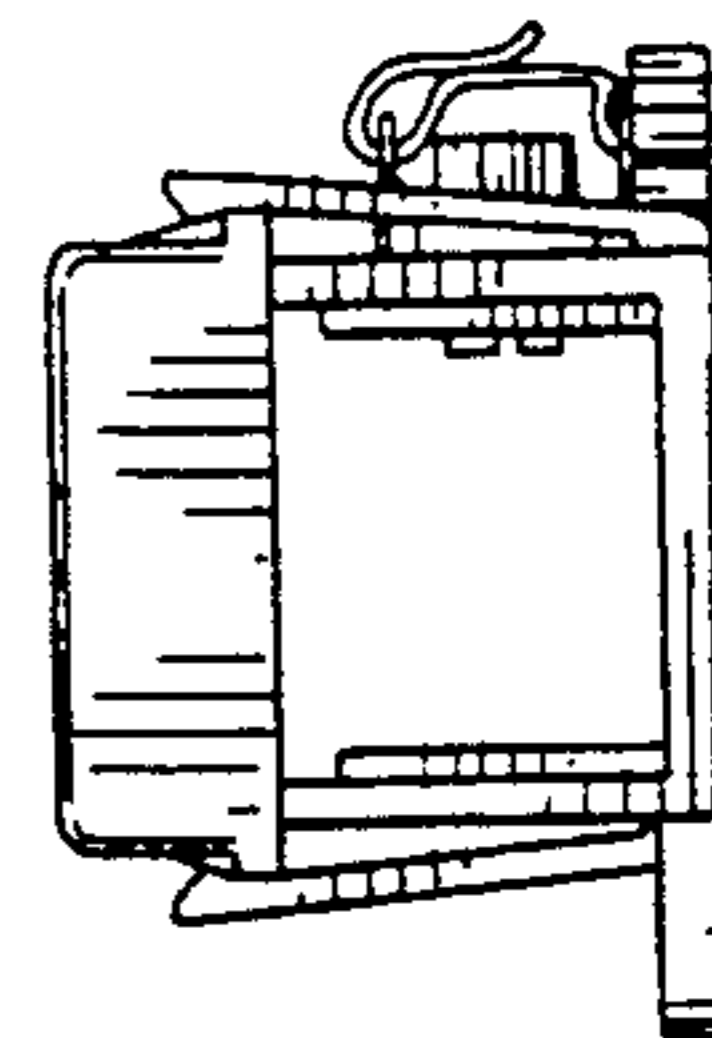


FIG. 29

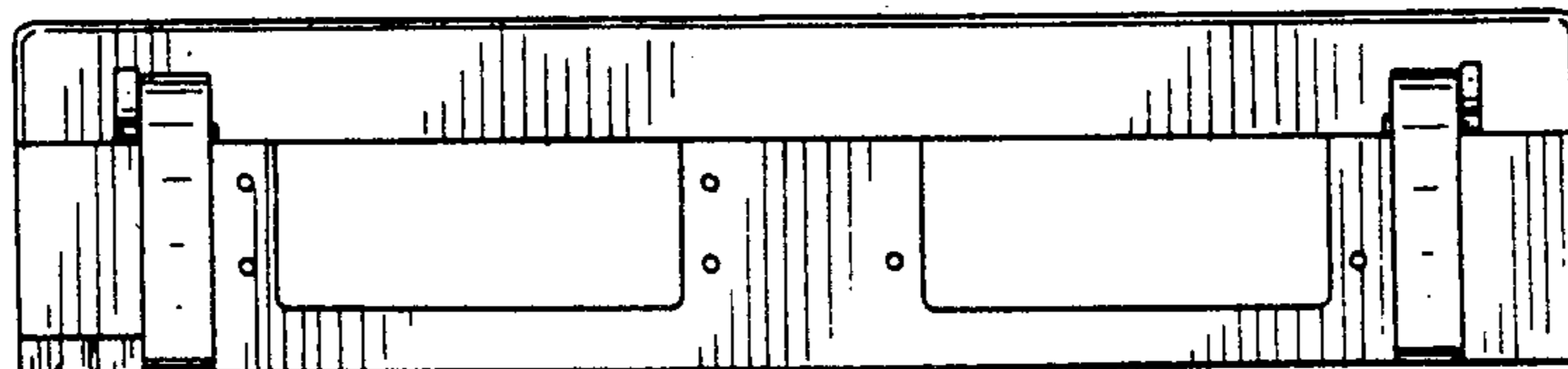


FIG. 28

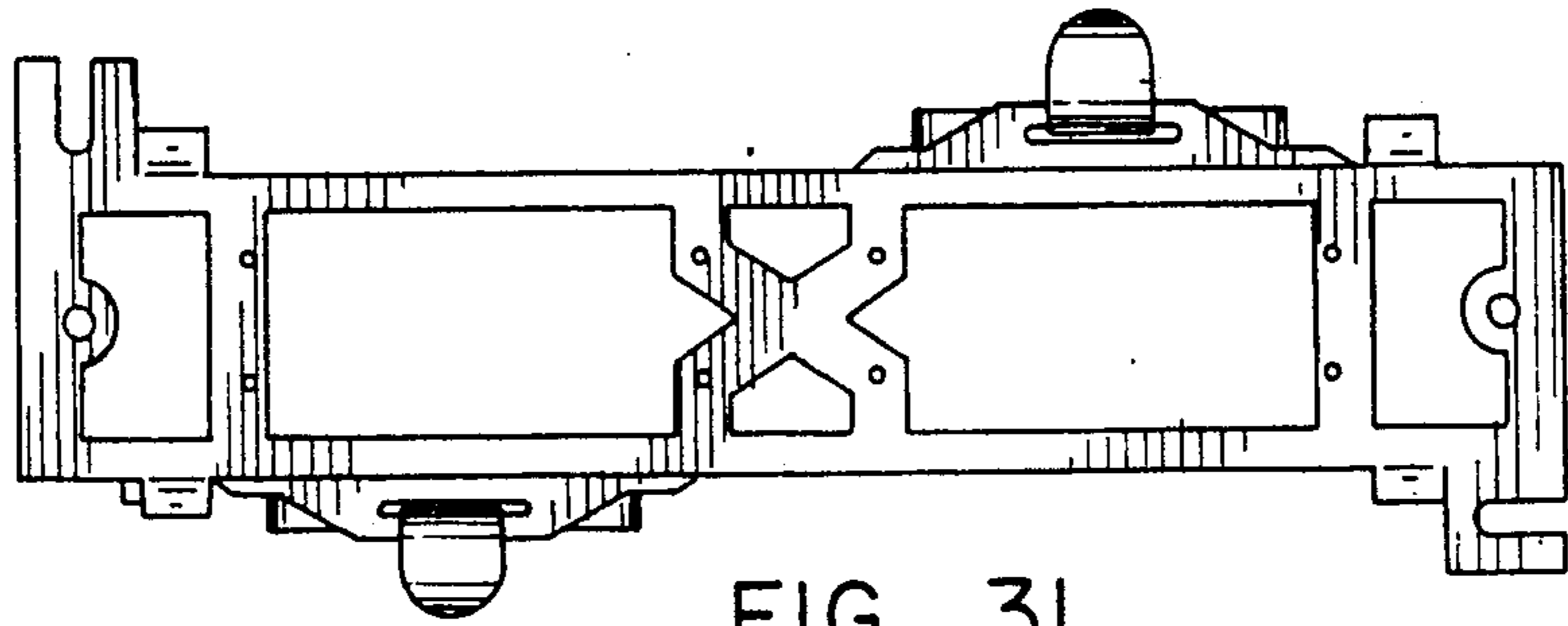


FIG. 31

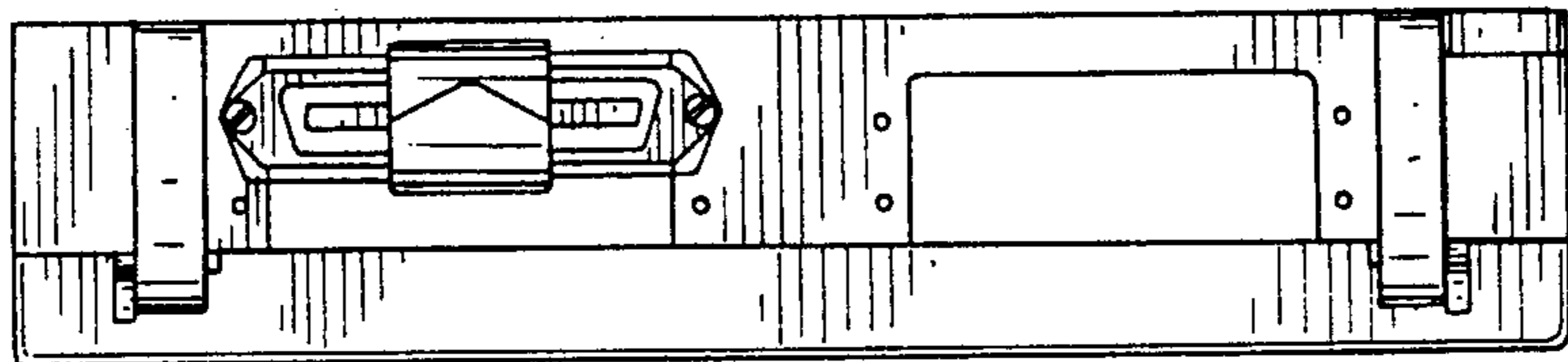


FIG. 33

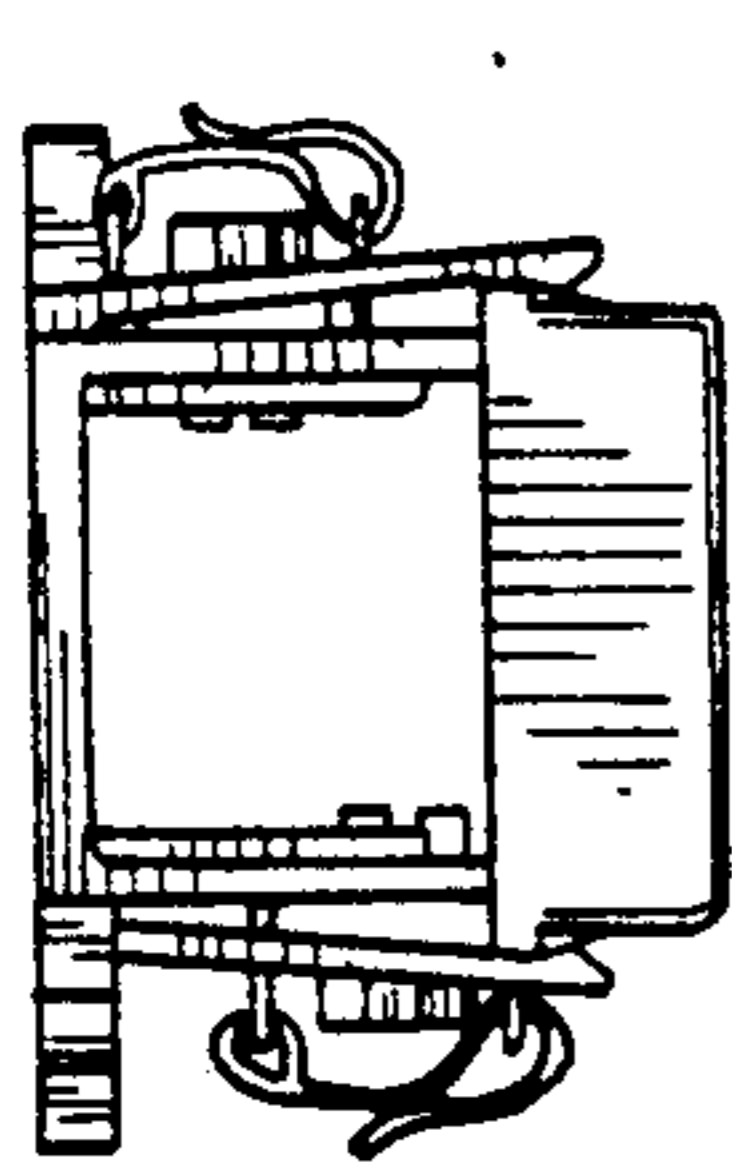


FIG. 36

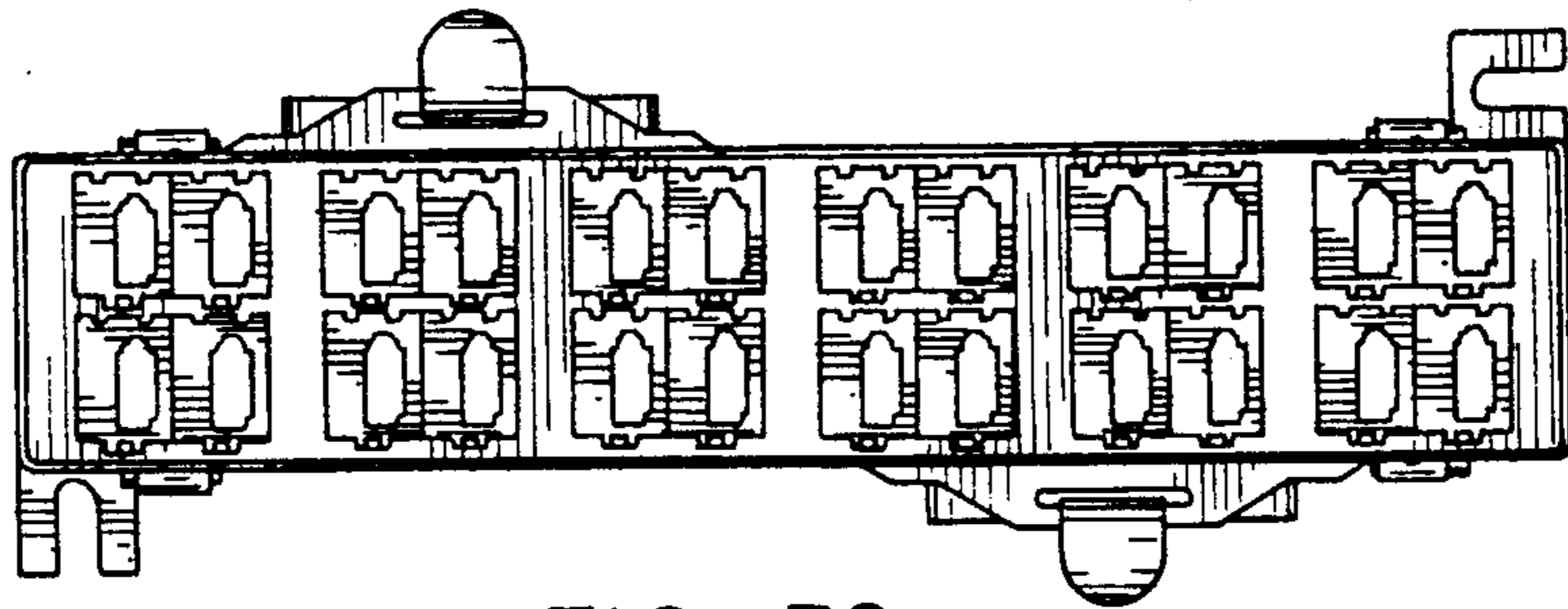


FIG. 32

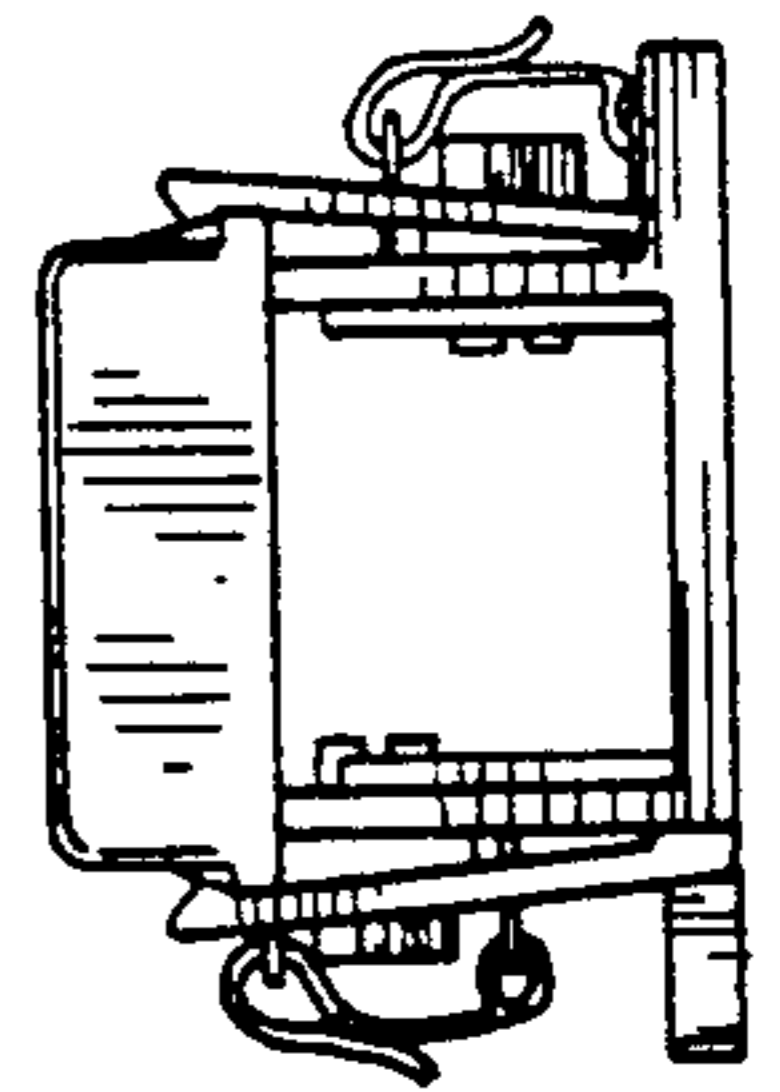


FIG. 35

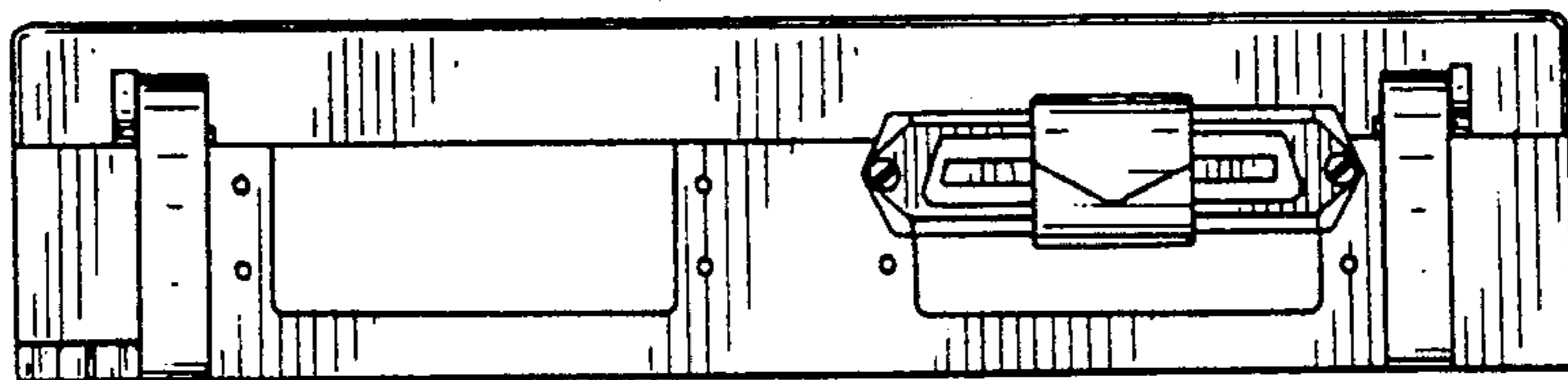


FIG. 34

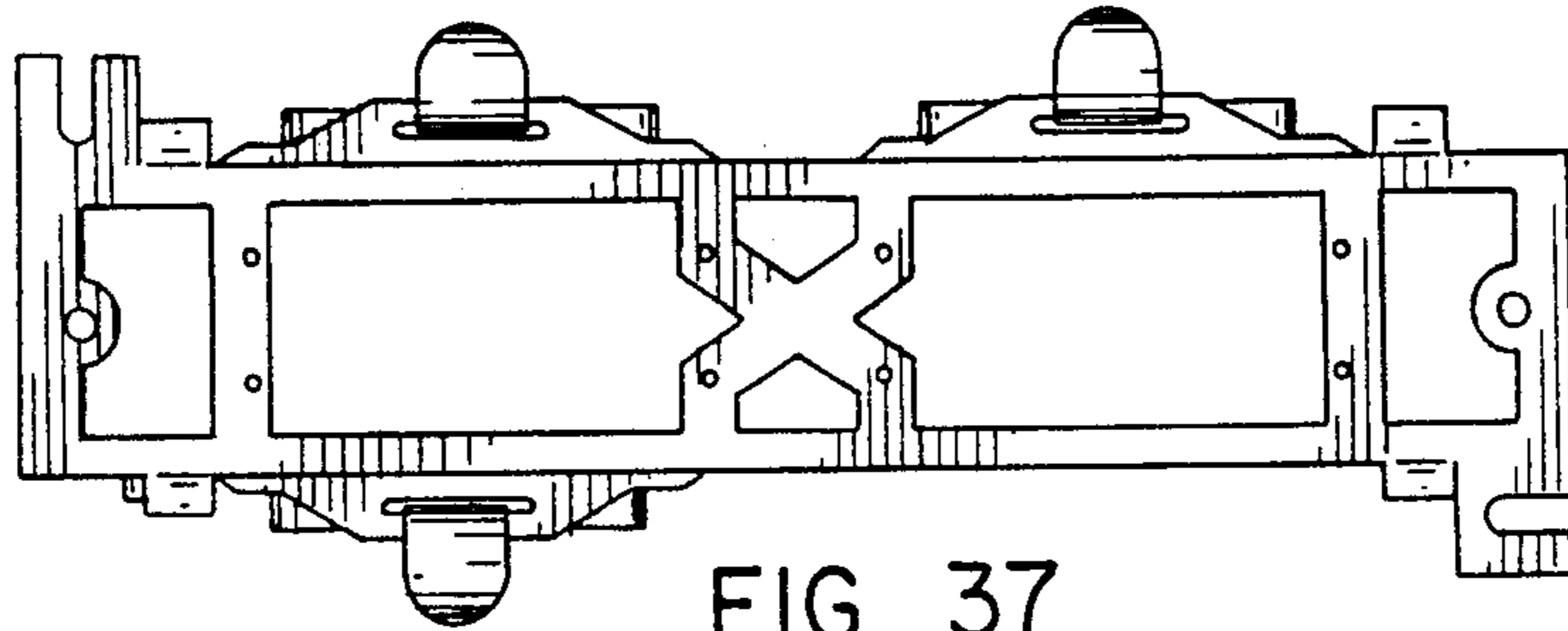


FIG. 37

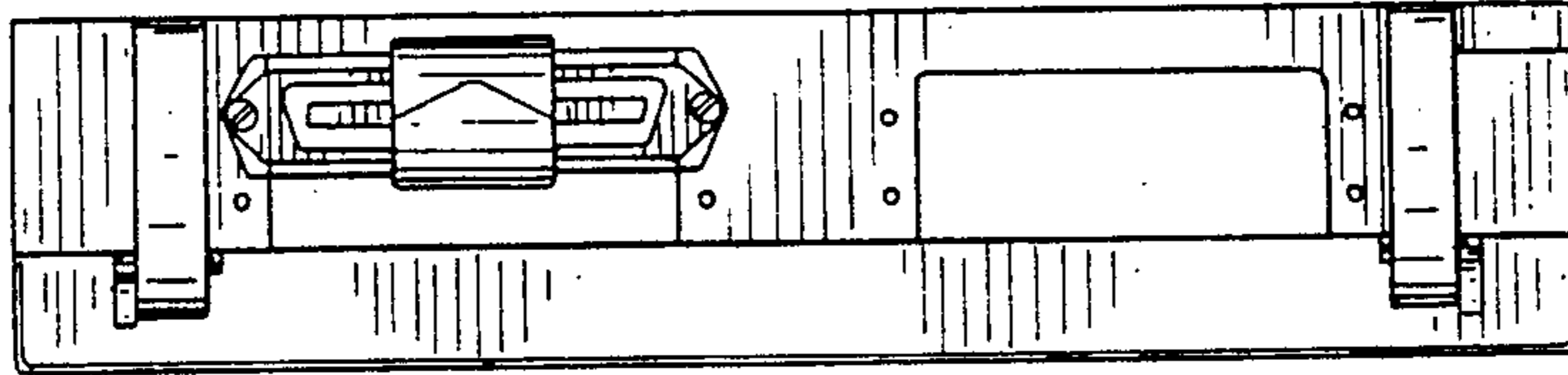


FIG. 39

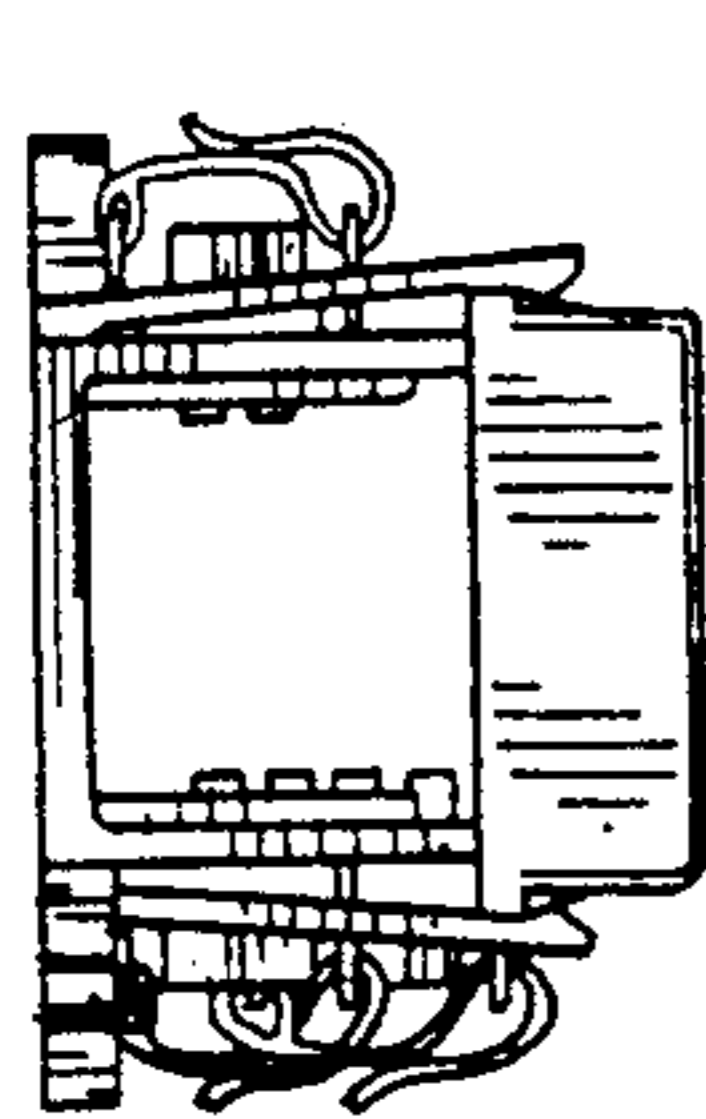


FIG. 42

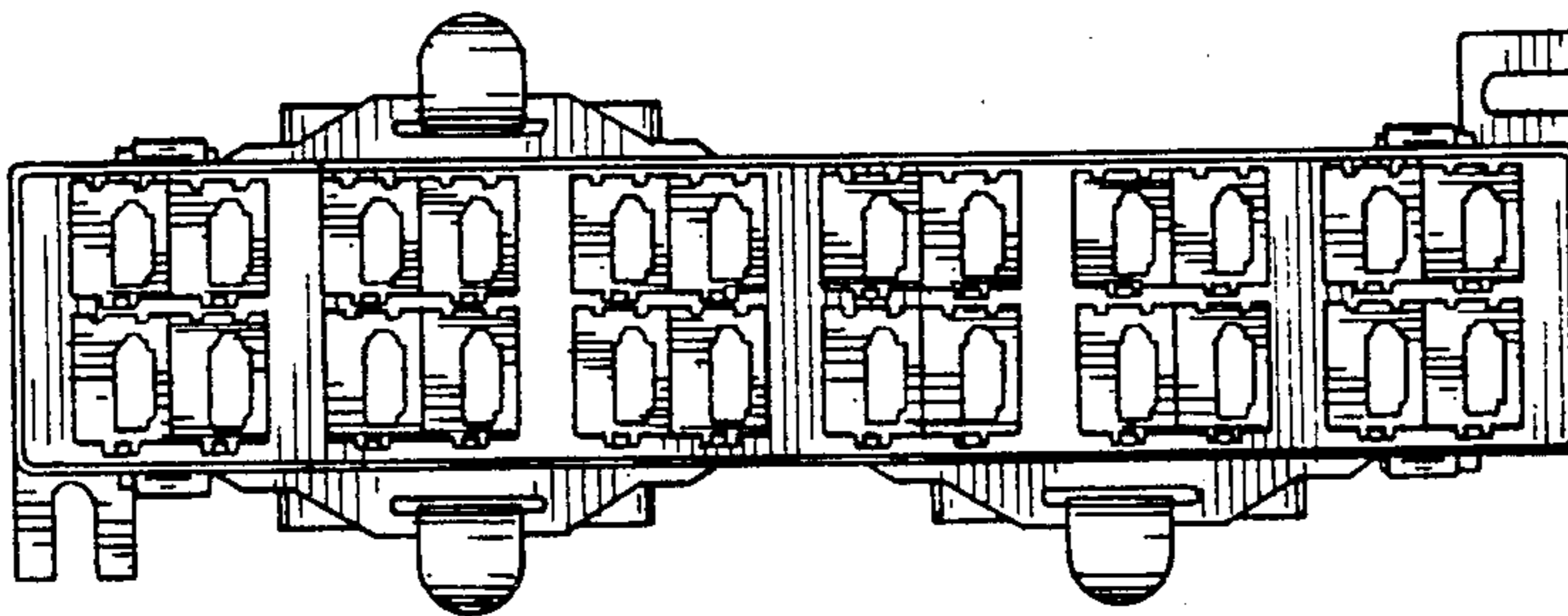


FIG. 38

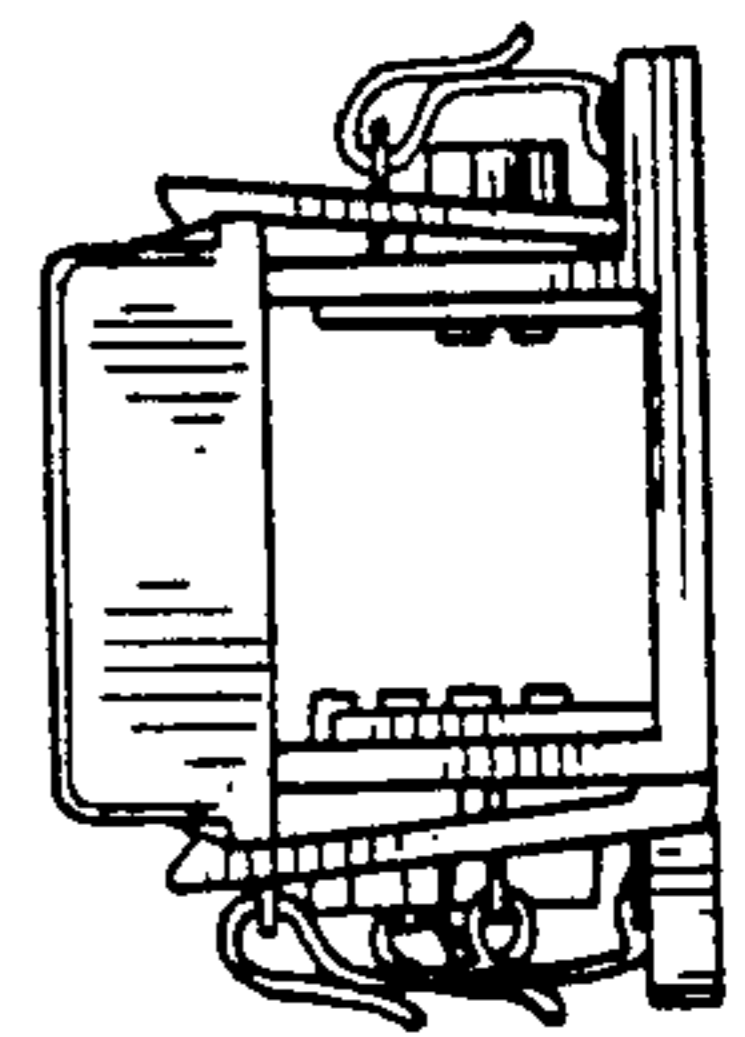


FIG. 41

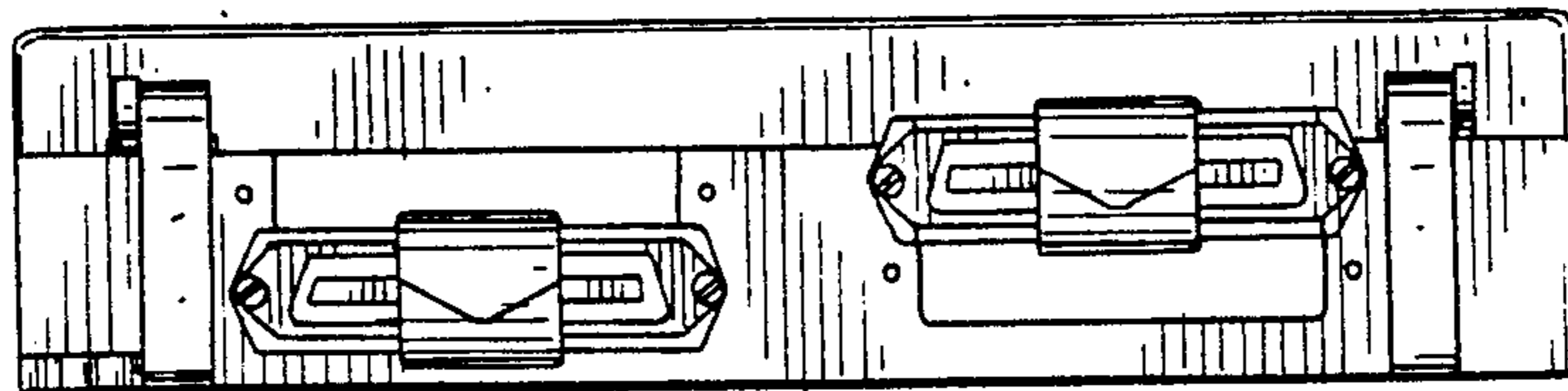


FIG. 40

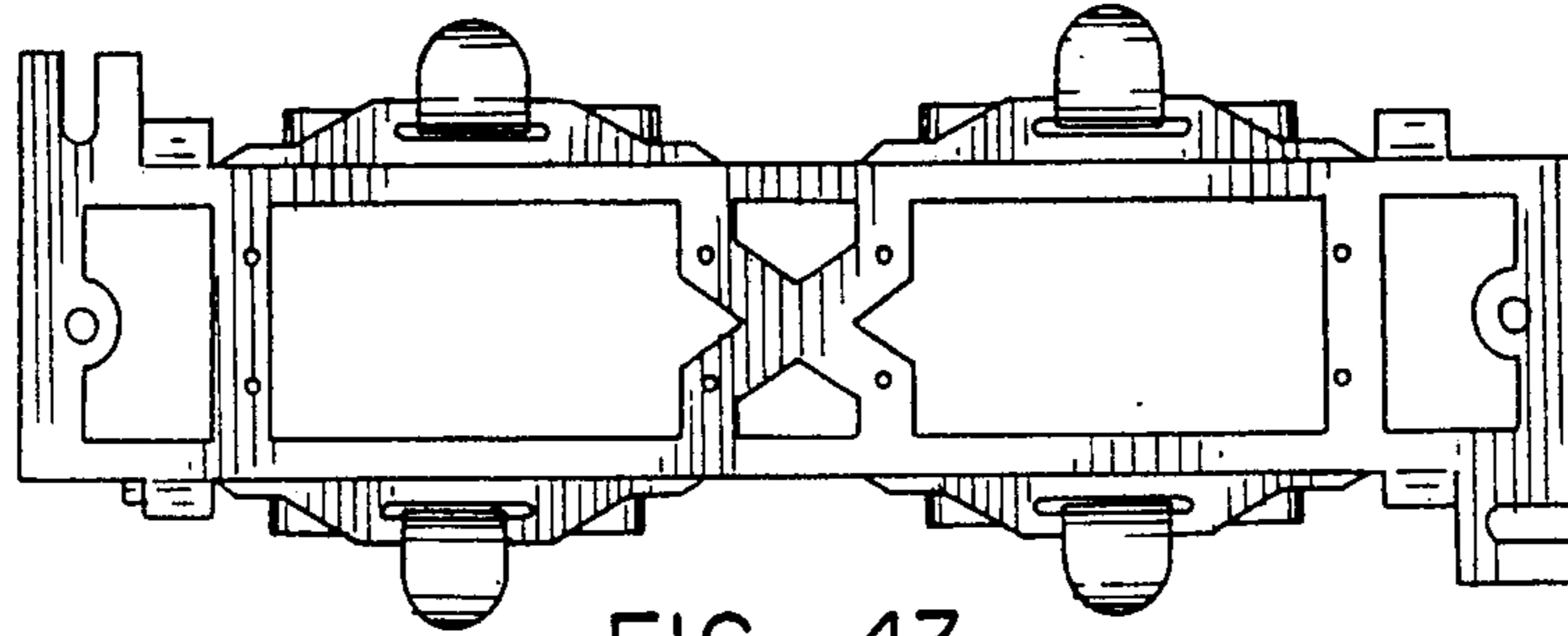


FIG. 43

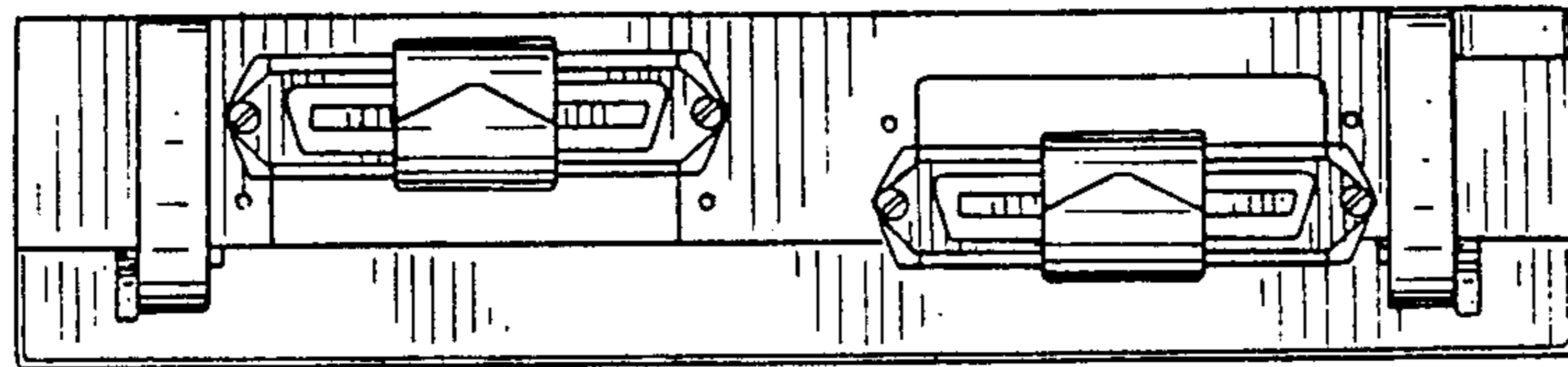


FIG. 45

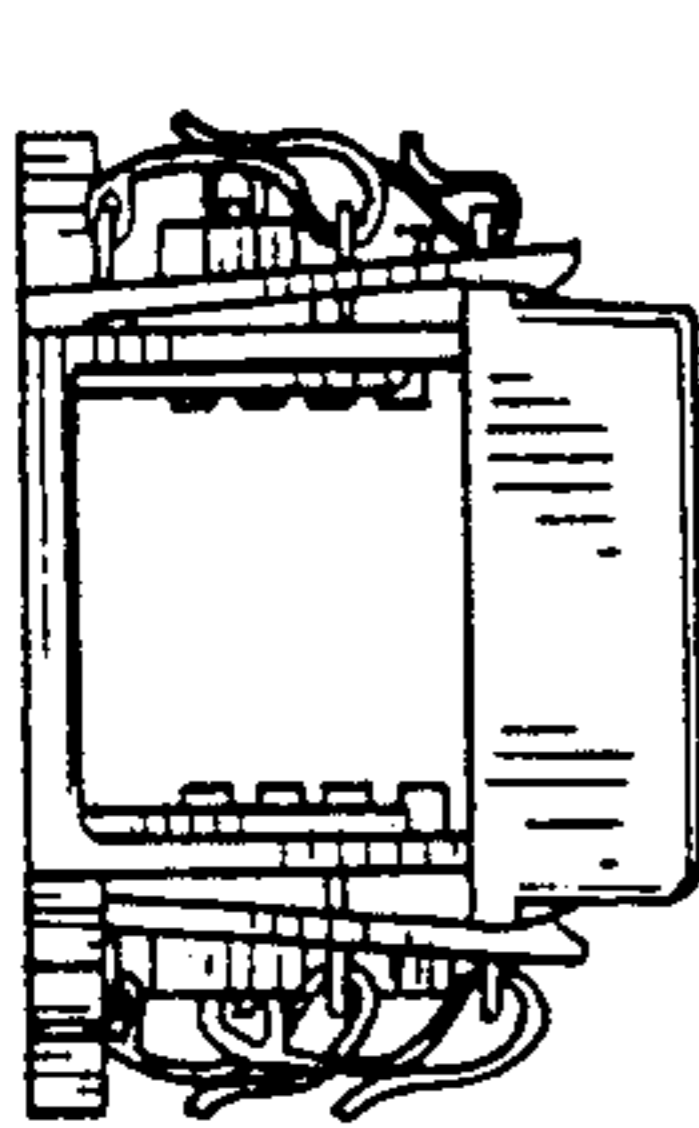


FIG. 48

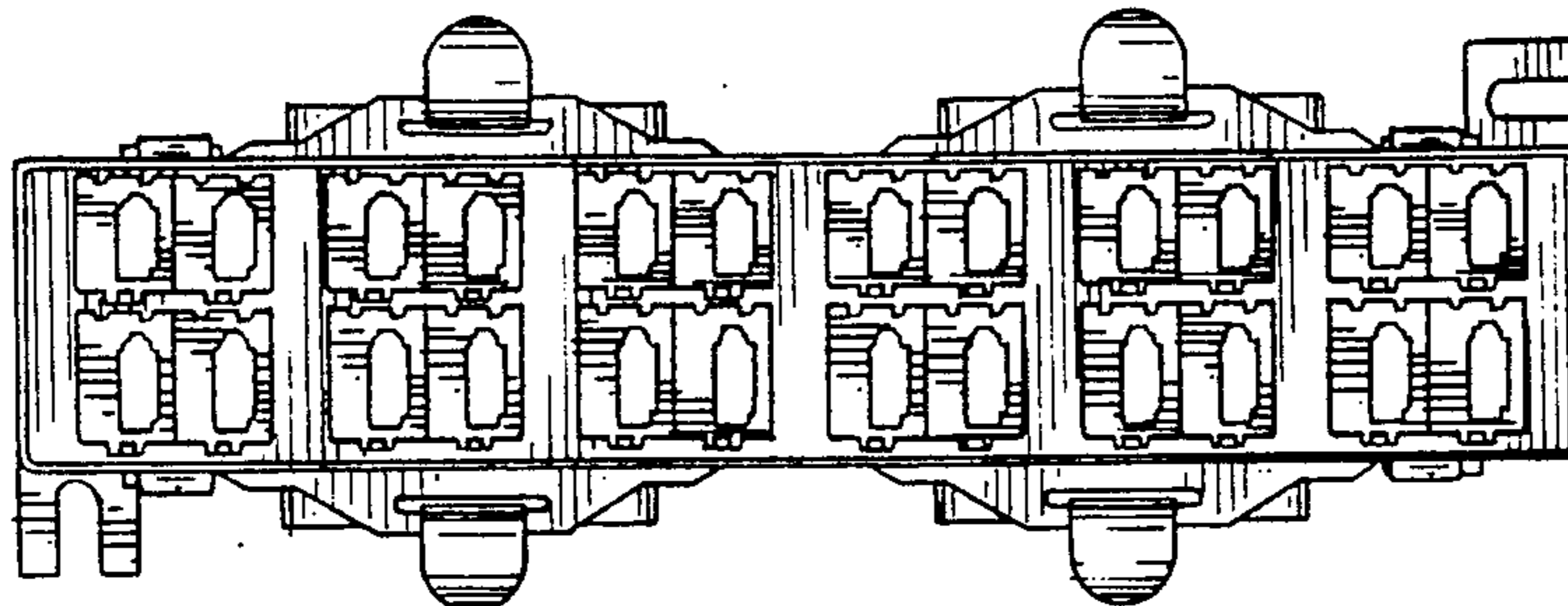


FIG. 44

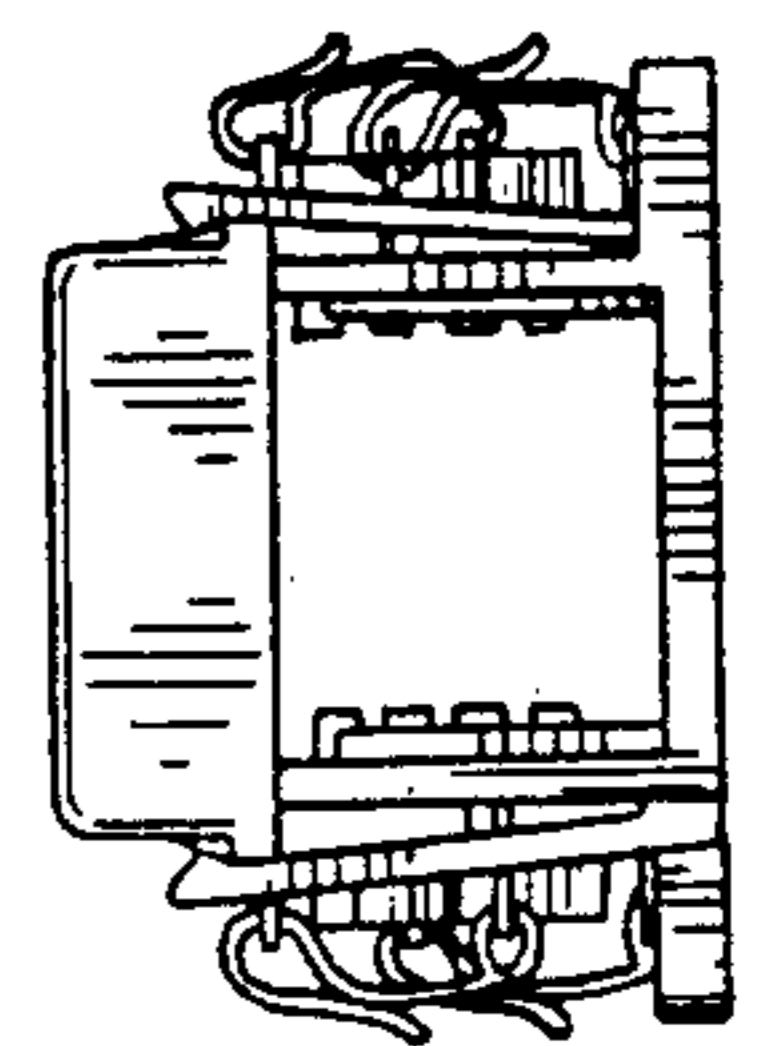


FIG. 47

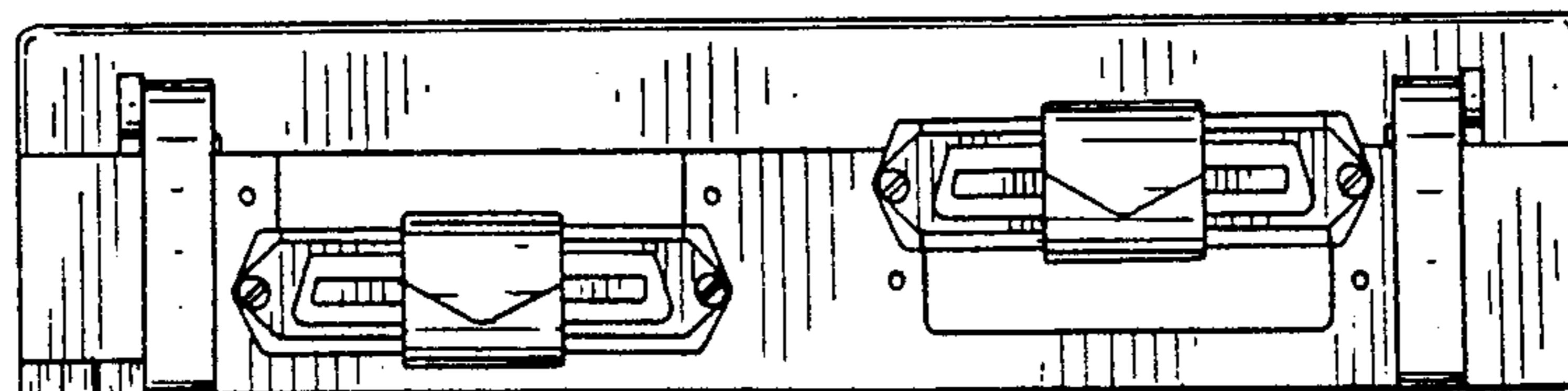


FIG. 46